

- **Advanced Multibus Architecture With Three Separate 16-Bit Data Memory Buses and One Program Memory Bus**
- **40-Bit Arithmetic Logic Unit (ALU) Including a 40-Bit Barrel Shifter and Two Independent 40-Bit Accumulators**
- **17- × 17-Bit Parallel Multiplier Coupled to a 40-Bit Dedicated Adder for Non-Pipelined Single-Cycle Multiply/Accumulate (MAC) Operation**
- **Compare, Select, and Store Unit (CSSU) for the Add/Compare Selection of the Viterbi Operator**
- **Exponent Encoder to Compute an Exponent Value of a 40-Bit Accumulator Value in a Single Cycle**
- **Two Address Generators With Eight Auxiliary Registers and Two Auxiliary Register Arithmetic Units (ARAUs)**
- **Data Bus With a Bus Holder Feature**
- **Address Bus With a Bus Holder Feature**
- **Extended Addressing Mode for 8M × 16-Bit Maximum Addressable External Program Space**
- **192K × 16-Bit Maximum Addressable Memory Space (64K Words Program, 64K Words Data, and 64K Words I/O)**
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- **Instructions With a 32-Bit Long Word Operand**
- **Instructions With Two- or Three-Operand Reads**
- **Arithmetic Instructions With Parallel Store and Parallel Load**
- **Conditional Store Instructions**
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- **On-Chip Peripherals**
  - **Software-Programmable Wait-State Generator and Programmable Bank Switching**
  - **On-Chip Phase-Locked Loop (PLL) Clock Generator With Internal Oscillator or External Clock Source**
  - **Time-Division Multiplexed (TDM) Serial Port**
  - **Buffered Serial Port (BSP)**
  - **8-Bit Parallel Host Port Interface (HPI)**
  - **One 16-Bit Timer**
  - **External-Input/Output (XIO) Off Control to Disable the External Data Bus, Address Bus and Control Signals**
- **Power Consumption Control With IDLE1, IDLE2, and IDLE3 Instructions With Power-Down Modes**
- **CLKOUT Off Control to Disable CLKOUT**
- **On-Chip Scan-Based Emulation Logic, IEEE Std 1149.1<sup>†</sup> (JTAG) Boundary Scan Logic**
- **15-ns Single-Cycle Fixed-Point Instruction Execution Time (66 MIPS) for 3.3-V Power Supply**
- **12.5-ns Single-Cycle Fixed-Point Instruction Execution Time (80 MIPS) for 3.3-V Power Supply**



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<sup>†</sup> IEEE Standard 1149.1-1990 Standard-Test-Access Port and Boundary Scan Architecture.

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# TMS320LC548 FIXED-POINT DIGITAL SIGNAL PROCESSOR

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## description

The TMS320LC548 fixed-point, digital signal processor (DSP) (hereafter referred to as the '548) is based on an advanced modified Harvard architecture that has one program memory bus and three data memory buses. The processor also provides an arithmetic logic unit (ALU) that has a high degree of parallelism, application-specific hardware logic, on-chip memory, and additional on-chip peripherals. The '548 also utilizes a highly specialized instruction set, which is the basis of its operational flexibility and speed.

Separate program and data spaces allow simultaneous access to program instructions and data, providing the high degree of parallelism. Two reads and one write operation can be performed in a single cycle. Instructions with parallel store and application-specific instructions can fully utilize this architecture. In addition, data can be transferred between data and program spaces. Such parallelism supports a powerful set of arithmetic, logic, and bit-manipulation operations that can all be performed in a single machine cycle. In addition, the '548 includes the control mechanisms to manage interrupts, repeated operations, and function calls.

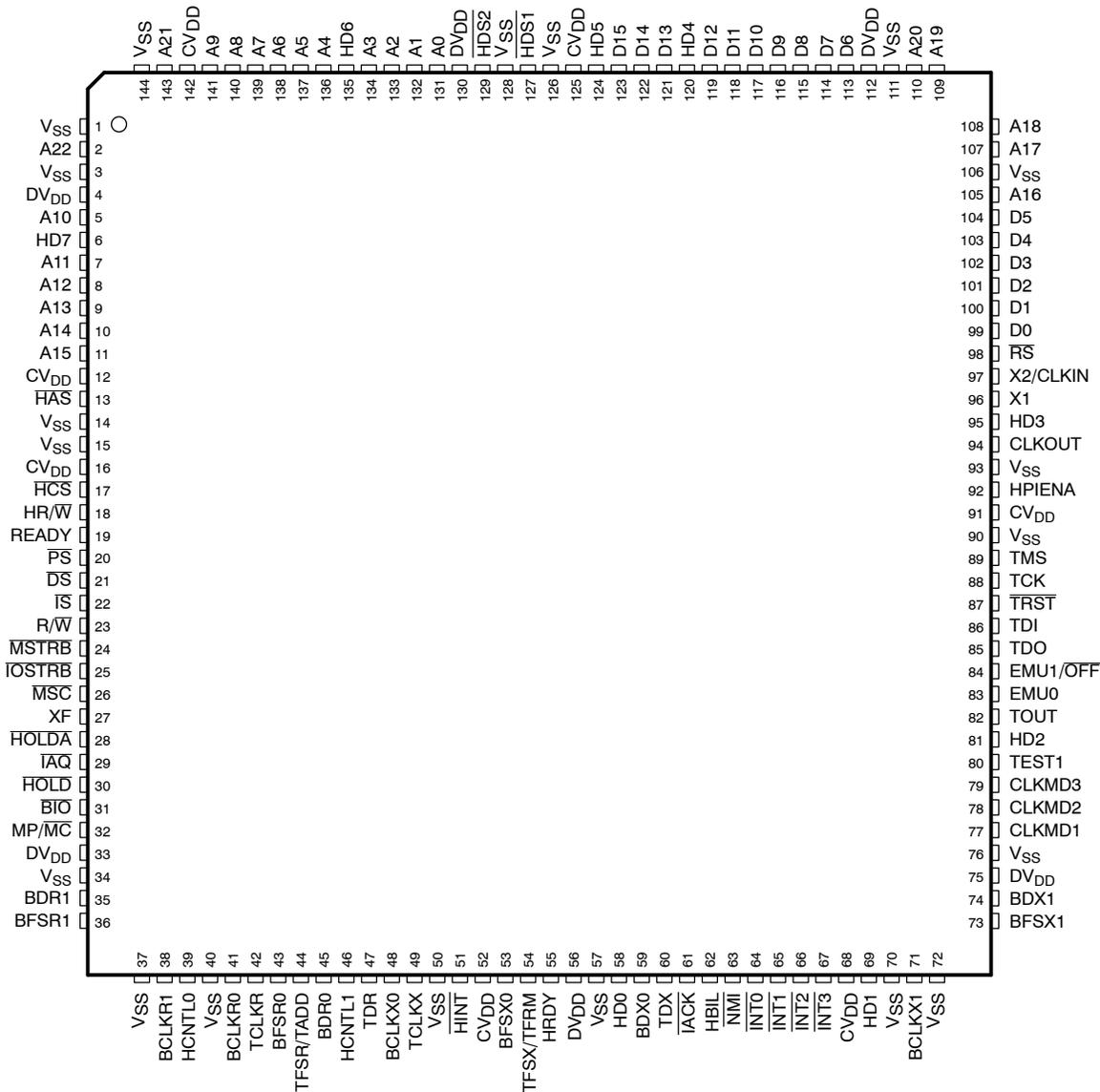
This data sheet contains the pin layouts, signal descriptions, and electrical specifications for the TMS320VC548 DSP. For additional information, see the *TMS320C54x*, *TMS320LC54x*, *TMS320VC54x Fixed-Point Digital Signal Processors* data sheet (literature number SPRS039). The SPRS039 is considered a family functional overview and should be used in conjunction with this data sheet.



# TMS320LC548 FIXED-POINT DIGITAL SIGNAL PROCESSOR

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## PGE PACKAGE†‡ (TOP VIEW)



† NC = No connection

‡ DV<sub>DD</sub> is the power supply for the I/O pins while CV<sub>DD</sub> is the power supply for the core CPU, and V<sub>SS</sub> is the ground for both the I/O pins and the core CPU.

The '548 signal descriptions table lists each terminal name, function, and operating mode(s) for the 144-pin thin quad flatpack (TQFP).

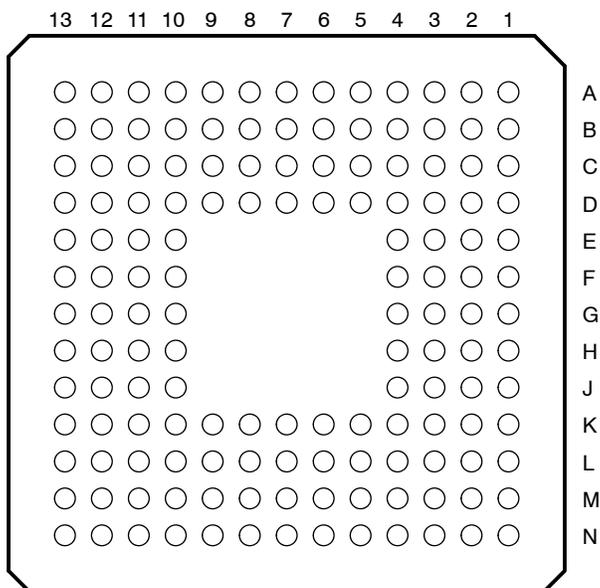
The letter B in front of CLKR<sub>n</sub>, FSR<sub>n</sub>, DR<sub>n</sub>, CLKX<sub>n</sub>, FSX<sub>n</sub>, and DX<sub>n</sub> pin names denotes buffered serial port (BSP), where n = 0 or 1 port. The letter T in front of CLKR, FSR, DR, CLKX, FSX, and DX pin names denotes time-division multiplexed (TDM) serial port.



# TMS320LC548 FIXED-POINT DIGITAL SIGNAL PROCESSOR

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## GGU PACKAGE (BOTTOM VIEW)



The pin assignments table to follow lists each signal quadrant and BGA ball pin number for the 144-pin BGA package.

The '548 signal descriptions table lists each terminal name, function, and operating mode(s) for the TMS320LC548GGU.

**Pin Assignments for the 144-Pin BGA Package<sup>†</sup>**

| SIGNAL QUADRANT 1 | BGA BALL # | SIGNAL QUADRANT 2 | BGA BALL # | SIGNAL QUADRANT 3 | BGA BALL # | SIGNAL QUADRANT 4 | BGA BALL # |
|-------------------|------------|-------------------|------------|-------------------|------------|-------------------|------------|
| V <sub>SS</sub>   | A1         | BFSX1             | N13        | V <sub>SS</sub>   | N1         | A19               | A13        |
| A22               | B1         | BDX1              | M13        | BCLKR1            | N2         | A20               | A12        |
| V <sub>SS</sub>   | C2         | DV <sub>DD</sub>  | L12        | HCNTL0            | M3         | V <sub>SS</sub>   | B11        |
| DV <sub>DD</sub>  | C1         | V <sub>SS</sub>   | L13        | V <sub>SS</sub>   | N3         | DV <sub>DD</sub>  | A11        |
| A10               | D4         | CLKMD1            | K10        | BCLKR0            | K4         | D6                | D10        |
| HD7               | D3         | CLKMD2            | K11        | TCLKR             | L4         | D7                | C10        |
| A11               | D2         | CLKMD3            | K12        | BFSR0             | M4         | D8                | B10        |
| A12               | D1         | TEST1             | K13        | TFSR/TADD         | N4         | D9                | A10        |
| A13               | E4         | HD2               | J10        | BDR0              | K5         | D10               | D9         |
| A14               | E3         | TOUT              | J11        | HCNTL1            | L5         | D11               | C9         |
| A15               | E2         | EMU0              | J12        | TDR               | M5         | D12               | B9         |
| CV <sub>DD</sub>  | E1         | EMU1/OFF          | J13        | BCLKX0            | N5         | HD4               | A9         |
| HAS               | F4         | TDO               | H10        | TCLKX             | K6         | D13               | D8         |
| V <sub>SS</sub>   | F3         | TDI               | H11        | V <sub>SS</sub>   | L6         | D14               | C8         |
| V <sub>SS</sub>   | F2         | TRST              | H12        | HINT              | M6         | D15               | B8         |
| CV <sub>DD</sub>  | F1         | TCK               | H13        | CVDD              | N6         | HD5               | A8         |
| HCS               | G2         | TMS               | G12        | BFSX0             | M7         | CV <sub>DD</sub>  | B7         |
| HR/W              | G1         | V <sub>SS</sub>   | G13        | TFSX/TFRM         | N7         | V <sub>SS</sub>   | A7         |
| READY             | G3         | CV <sub>DD</sub>  | G11        | HRDY              | L7         | HDS1              | C7         |
| PS                | G4         | HPIENA            | G10        | DV <sub>DD</sub>  | K7         | V <sub>SS</sub>   | D7         |
| DS                | H1         | V <sub>SS</sub>   | F13        | V <sub>SS</sub>   | N8         | HDS2              | A6         |
| TS                | H2         | CLKOUT            | F12        | HD0               | M8         | DV <sub>DD</sub>  | B6         |
| R/W               | H3         | HD3               | F11        | BDX0              | L8         | A0                | C6         |
| MSTRB             | H4         | X1                | F10        | TDX               | K8         | A1                | D6         |
| IOSTRB            | J1         | X2/CLKIN          | E13        | IACK              | N9         | A2                | A5         |
| MSC               | J2         | RS                | E12        | HBIL              | M9         | A3                | B5         |
| XF                | J3         | D0                | E11        | NMI               | L9         | HD6               | C5         |
| HOLDA             | J4         | D1                | E10        | INT0              | K9         | A4                | D5         |
| IAQ               | K1         | D2                | D13        | INT1              | N10        | A5                | A4         |
| HOLD              | K2         | D3                | D12        | INT2              | M10        | A6                | B4         |
| BIO               | K3         | D4                | D11        | INT3              | L10        | A7                | C4         |
| MP/MC             | L1         | D5                | C13        | CV <sub>DD</sub>  | N11        | A8                | A3         |
| DV <sub>DD</sub>  | L2         | A16               | C12        | HD1               | M11        | A9                | B3         |
| V <sub>SS</sub>   | L3         | V <sub>SS</sub>   | C11        | V <sub>SS</sub>   | L11        | CV <sub>DD</sub>  | C3         |
| BDR1              | M1         | A17               | B13        | BCLKX1            | N12        | A21               | A2         |
| BFSR1             | M2         | A18               | B12        | V <sub>SS</sub>   | M12        | V <sub>SS</sub>   | B2         |

<sup>†</sup> DV<sub>DD</sub> is the power supply for the I/O pins while CV<sub>DD</sub> is the power supply for the core CPU, and V<sub>SS</sub> is the ground for both the I/O pins and the core CPU.

# TMS320LC548 FIXED-POINT DIGITAL SIGNAL PROCESSOR

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## Signal Descriptions

| TERMINAL<br>NAME  | TYPE† | DESCRIPTION  |
|---|-------|--|
| <b>DATA SIGNALS</b>   |       |  |
| A22 (MSB)<br>A21<br>A20<br>A19<br>A18<br>A17<br>A16<br>A15<br>A14<br>A13<br>A12<br>A11<br>A10<br>A9<br>A8<br>A7<br>A6<br>A5<br>A4<br>A3<br>A2<br>A1<br>A0 (LSB) | O/Z   | Parallel port address bus A22 (MSB) through A0 (LSB). The sixteen LSBs (A15-A0) are multiplexed to address external data/program memory or I/O. A15-A0 are placed in the high-impedance state in the hold mode. A15-A0 also go into the high-impedance state when EMU1/OFF is low. The seven MSBs (A22 to A16) are used for extended program memory addressing.<br>The address bus have a feature called bus holder that eliminates passive components and the power dissipation associated with it. The bus holders keep the address bus at the previous logic level when the bus goes into a high-impedance state. The bus holders on the address bus are always enabled.            |
| D15 (MSB)<br>D14<br>D13<br>D12<br>D11<br>D10<br>D9<br>D8<br>D7<br>D6<br>D5<br>D4<br>D3<br>D2<br>D1<br>D0 (LSB)  | I/O/Z | Parallel port data bus D15 (MSB) through D0 (LSB). D15-D0 are multiplexed to transfer data between the core CPU and external data/program memory or I/O devices. D15-D0 are placed in the high-impedance state when not output or when RS or HOLD is asserted. D15-D0 also go into the high-impedance state when EMU1/OFF is low.<br>The data bus has a feature called bus holder that eliminates passive components and the power dissipation associated with it. The bus holders keep the data bus at the previous logic level when the bus goes into a high-impedance state. These bus holders are enabled or disabled by the BH bit in the bank switching control register (BSCR). |
| <b>INITIALIZATION, INTERRUPT AND RESET OPERATIONS</b>   |       |  |
| $\overline{\text{IACK}}$  | O/Z   | Interrupt acknowledge signal. $\overline{\text{IACK}}$ indicates the receipt of an interrupt and that the program counter is fetching the interrupt vector location designated by A15-0. $\overline{\text{IACK}}$ also goes into the high-impedance state when EMU1/OFF is low.  |
| $\overline{\text{INT0}}$<br>$\overline{\text{INT1}}$<br>$\overline{\text{INT2}}$<br>$\overline{\text{INT3}}$  | I     | External user interrupt inputs. $\overline{\text{INT0}}$ - $\overline{\text{INT3}}$ are prioritized and are maskable by the interrupt mask register and the interrupt mode bit. $\overline{\text{INT0}}$ - $\overline{\text{INT3}}$ can be polled and reset by the interrupt flag register.  |

† I = Input, O = Output, Z = High impedance



### Signal Descriptions (Continued)

| TERMINAL<br>NAME  | TYPE† | DESCRIPTION   |
|---|-------|---|
| <b>INITIALIZATION, INTERRUPT AND RESET OPERATIONS (CONTINUED)</b> |       |   |
| NMI   | I     | Nonmaskable interrupt. NMI is an external interrupt that cannot be masked by way of the INTM or the IMR. When NMI is activated, the processor traps to the appropriate vector location.   |
| RS  | I     | Reset input. RS causes the DSP to terminate execution and forces the program counter to 0FF80h. When RS is brought to a high level, execution begins at location 0FF80h of the program memory. RS affects various registers and status bits.  |
| MP/MC   | I     | Microprocessor/microcomputer mode-select pin. If active-low at reset (microcomputer mode), MP/MC causes the internal program ROM to be mapped into the upper program memory space. In the microprocessor mode, off-chip memory and its corresponding addresses (instead of internal program ROM) are accessed by the DSP.   |
| CNT   | I     | I/O level select. For 5-V operation, all input and output voltage levels are TTL-compatible when CNT is pulled down to a low level. For 3-V operation with CMOS-compatible I/O interface levels, CNT is pulled to a high level.   |
| <b>MULTIPROCESSING SIGNALS</b>                                    |       |   |
| BIO   | I     | Branch control input. A branch can be conditionally executed when BIO is active. If low, the processor executes the conditional instruction. The BIO condition is sampled during the decode phase of the pipeline for the XC instruction, and all other instructions sample BIO during the read phase of the pipeline.  |
| XF  | O/Z   | External flag output (latched software-programmable signal). XF is set high by the SSBX XF instruction, set low by RSBX XF instruction or by loading the ST1 status register. XF is used for signaling other processors in multiprocessor configurations or as a general-purpose output pin. XF goes into the high-impedance state when OFF is low, and is set high at reset.                         |
| <b>MEMORY CONTROL SIGNALS</b>                                     |       |   |
| DS<br>PS<br>IS  | O/Z   | Data, program, and I/O space select signals. DS, PS, and IS are always high unless driven low for communicating to a particular external space. Active period corresponds to valid address information. Placed into a high-impedance state in hold mode. DS, PS, and IS also go into the high-impedance state when EMU1/OFF is low.   |
| MSTRB   | O/Z   | Memory strobe signal. MSTRB is always high unless low-level asserted to indicate an external bus access to data or program memory. Placed in high-impedance state in hold mode. MSTRB also goes into the high-impedance state when OFF is low.  |
| READY   | I     | Data-ready input. READY indicates that an external device is prepared for a bus transaction to be completed. If the device is not ready (READY is low), the processor waits one cycle and checks READY again. Note that the processor performs ready-detection if at least two software wait states are programmed. The READY signal is not sampled until the completion of the software wait states. |
| R/W   | O/Z   | Read/write signal. R/W indicates transfer direction during communication to an external device and is normally high (in read mode), unless asserted low when the DSP performs a write operation. Placed in the high-impedance state in hold mode, R/W also goes into the high-impedance state when EMU1/OFF is low.   |
| IOSTRB  | O/Z   | I/O strobe signal. IOSTRB is always high unless low level asserted to indicate an external bus access to an I/O device. Placed in high-impedance state in hold mode. IOSTRB also goes into the high-impedance state when EMU1/OFF is low.   |
| HOLD  | I     | Hold input. HOLD is asserted to request control of the address, data, and control lines. When acknowledged by the '54x, these lines go into high-impedance state.   |
| HOLDA   | O/Z   | Hold acknowledge signal. HOLDA indicates to the external circuitry that the processor is in a hold state and that the address, data, and control lines are in a high-impedance state, allowing them to be available to the external circuitry. HOLDA also goes into the high-impedance state when EMU1/OFF is low.  |
| MSC   | O/Z   | Microstate complete signal. Goes low on CLKOUT falling at the start of the first software wait state. Remains low until one CLKOUT cycle before the last programmed software wait state. If connected to the READY line, MSC forces one external wait state after the last internal wait state has been completed. MSC also goes into the high-impedance state when EM1/OFF is low.                   |

† I = Input, O = Output, Z = High impedance



# TMS320LC548 FIXED-POINT DIGITAL SIGNAL PROCESSOR

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## Signal Descriptions (Continued)

| TERMINAL NAME  | TYPE† | DESCRIPTION   |
|--|-------|---|
| <b>MEMORY CONTROL SIGNALS (CONTINUED)</b>                        |       |   |
| IAQ  | O/Z   | Instruction acquisition signal. $\overline{IAQ}$ is asserted (active low) when there is an instruction address on the address bus and goes into the high-impedance state when EMU1/ $\overline{OFF}$ is low.  |
| <b>OSCILLATOR/TIMER SIGNALS</b>                                  |       |   |
| CLKOUT   | O/Z   | Master clock output signal. CLKOUT cycles at the machine-cycle rate of the CPU. The internal machine cycle is bounded by the falling edges of this signal. CLKOUT also goes into the high-impedance state when EMU1/ $\overline{OFF}$ is low.   |
| CLKMD1<br>CLKMD2<br>CLKMD3                                       | I     | Clock mode external/internal input signals. CLKMD1, CLKMD2, and CLKMD3 allow you to select and configure different clock modes, such as crystal, external clock, and various PLL factors. Refer to PLL section for a detailed functional description of these pins.   |
| X2/CLKIN   | I     | Input pin to internal oscillator from the crystal. If the internal (crystal) oscillator is not being used, a clock can become input to the device using this pin. The internal machine cycle time is determined by the clock operating-mode pins (CLKMD1, CLKMD2 and CLKMD3).   |
| X1   | O     | Output pin from the internal oscillator for the crystal. If the internal oscillator is not used, X1 should be left unconnected. X1 does not go into the high-impedance state when EMU1/ $\overline{OFF}$ is low.  |
| TOUT   | O/Z   | Timer output. TOUT signals a pulse when the on-chip timer counts down past zero. The pulse is a CLKOUT-cycle wide. TOUT also goes into the high-impedance state when EMU1/ $\overline{OFF}$ is low.   |
| <b>BUFFERED SERIAL PORT 0 AND BUFFERED SERIAL PORT 1 SIGNALS</b> |       |   |
| BCLKR0<br>BCLKR1   | I     | Receive clocks. External clock signal for clocking data from the data-receive (DR) pin into the buffered serial port receive shift registers (RSRs). Must be present during buffered serial port transfers. If the buffered serial port is not being used, BCLKR0 and BCLKR1 can be sampled as an input by way of IN0 bit of the SPC register.  |
| BCLKX0<br>BCLKX1   | I/O/Z | Transmit clock. Clock signal for clocking data from the serial port transmit shift register (XSR) to the data transmit (DX) pin. BCLKX can be an input if MCM in the serial port control register is cleared to 0. It also can be driven by the device at $1/(\text{CLKDV} + 1)$ where CLKDV range is 0-31 CLKOUT frequency when MCM is set to 1. If the buffered serial port is not used, BCLKX can be sampled as an input by way of IN1 of the SPC register. BCLKX0 and BCLKX1 go into the high-impedance state when $\overline{OFF}$ is low. |
| BDR0<br>BDR1   | I     | Buffered serial-data-receive input. Serial data is received in the RSR by BDR0/BDR1.  |
| BDX0<br>BDX1   | O/Z   | Buffered serial-port-transmit output. Serial data is transmitted from the XSR by way of BDX. BDX0 and BDX1 are placed in the high-impedance state when not transmitting and when EMU1/ $\overline{OFF}$ is low.   |
| BFSR0<br>BFSR1   | I     | Frame synchronization pulse for receive input. The falling edge of the BFSR pulse initiates the data-receive process, beginning the clocking of the RSR.  |
| BFSX0<br>BFSX1   | I/O/Z | Frame synchronization pulse for transmit input/output. The falling edge of the BFSX pulse initiates the data-transmit process, beginning the clocking of the XSR. Following reset, the default operating condition of BFSX is an input. BFSX0 and BFSX1 can be selected by software to be an output when TXM in the serial control register is set to 1. This pin goes into the high-impedance state when EMU1/ $\overline{OFF}$ is low.  |
| <b>SERIAL PORT 0 AND SERIAL PORT 1 SIGNALS</b>                   |       |   |
| CLKR0<br>CLKR1   | I     | Receive clocks. External clock signal for clocking data from the data receive (DR) pin into the serial port receive shift register (RSR). Must be present during serial port transfers. If the serial port is not being used, CLKR0 and CLKR1 can be sampled as an input via IN0 bit of the SPC register.   |
| CLKX0<br>CLKX1   | I/O/Z | Transmit clock. Clock signal for clocking data from the serial port transmit shift register (XSR) to the data transmit (DX) pin. CLKX can be an input if MCM in the serial port control register is cleared to 0. It also can be driven by the device at $1/4$ CLKOUT frequency when MCM is set to 1. If the serial port is not used, CLKX can be sampled as an input via IN1 of the SPC register. CLKX0 and CLKX1 go into the high-impedance state when EMU1/ $\overline{OFF}$ is low.   |
| DR0<br>DR1   | I     | Serial-data-receive input. Serial data is received in the RSR by DR.  |

† I = Input, O = Output, Z = High impedance



### Signal Descriptions (Continued)

| TERMINAL<br>NAME   | TYPE†  | DESCRIPTION  |
|--|--------|--|
| <b>SERIAL PORT 0 AND SERIAL PORT 1 SIGNALS (CONTINUED)</b> |        |  |
| DX0<br>DX1   | O/Z    | Serial port transmit output. Serial data is transmitted from the XSR via DX. DX0 and DX1 are placed in the high-impedance state when not transmitting and when EMU1/OFF is low.  |
| FSR0<br>FSR1   | I      | Frame synchronization pulse for receive input. The falling edge of the FSR pulse initiates the data-receive process, beginning the clocking of the RSR.  |
| FSX0<br>FSX1   | I/O/Z  | Frame synchronization pulse for transmit input/output. The falling edge of the FSX pulse initiates the data transmit process, beginning the clocking of the XSR. Following reset, the default operating condition of FSX is an input. FSX0 and FSX1 can be selected by software to be an output when TXM in the serial control register is set to 1. This pin goes into the high-impedance state when EMU1/OFF is low.   |
| <b>TDM SERIAL PORT SIGNALS</b>                             |        |  |
| TCLKR  | I      | TDM receive clock input  |
| TDR  | I      | TDM serial data-receive input  |
| TFSR/TADD  | I/O    | TDM receive frame synchronization or TDM address   |
| TCLKX  | I/O/Z  | TDM transmit clock   |
| TDX  | O/Z    | TDM serial data-transmit output  |
| TFSX/TFRM  | I/O/Z  | TDM transmit frame synchronization   |
| <b>HOST PORT INTERFACE SIGNALS</b>                         |        |  |
| HD0-HD7  | I/O/Z  | Parallel bidirectional data bus. HD0-HD7 are placed in the high-impedance state when not outputting data. The signals go into the high-impedance state when EMU1/OFF is low. These pins each have bus holders similar to those on the address/data bus, but which are always enabled.  |
| HCNTL0<br>HCNTL1   | I      | Control inputs   |
| HBIL   | I      | Byte-identification input  |
| HCS  | I      | Chip-select input  |
| HDS1<br>HDS2   | I      | Data strobe inputs   |
| HAS  | I      | Address strobe input   |
| HR/W   | I      | Read/write input   |
| HRDY   | O/Z    | Ready output. This signal goes into the high-impedance state when EMU1/OFF is low.   |
| HINT   | O/Z    | Interrupt output. When the DSP is in reset, this signal is driven high. The signal goes into the high-impedance state when EMU1/OFF is low.  |
| HPIENA   | I      | HPI module select input. This signal must be tied to a logic 1 state to have HPI selected. If this input is left open or connected to ground, the HPI module will not be selected, internal pullup for the HPI input pins are enabled, and the HPI data bus has keepers set. This input is provided with an internal pull-down resistor which is active only when RS is low. HPIENA is sampled when RS goes high and ignored until RS goes low again. Refer to the Electrical Characteristics section for the input current requirements for this pin. |
| <b>SUPPLY PINS</b>   |        |  |
| CV <sub>DD</sub>   | Supply | +V <sub>DD</sub> . CV <sub>DD</sub> is the dedicated power supply for the core CPU.  |
| DV <sub>DD</sub>   | Supply | +V <sub>DD</sub> . DV <sub>DD</sub> is the dedicated power supply for I/O pins.  |
| V <sub>SS</sub>  | Supply | Ground. V <sub>SS</sub> is the dedicated power ground for the device.  |

† I = Input, O = Output, Z = High impedance

# TMS320LC548 FIXED-POINT DIGITAL SIGNAL PROCESSOR

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## Signal Descriptions (Continued)

| TERMINAL NAME               | TYPE† | DESCRIPTION  |
|-----------------------------|-------|--|
| <b>IEEE1149.1 TEST PINS</b> |       |  |
| TCK                         | I     | IEEE standard 1149.1 test clock. Pin with internal pullup device. This is normally a free-running clock signal with a 50% duty cycle. The changes on the test-access port (TAP) of input signals TMS and TDI are clocked into the TAP controller, instruction register, or selected test data register on the rising edge of TCK. Changes at the TAP output signal (TDO) occur on the falling edge of TCK.   |
| TDI                         | I     | IEEE standard 1149.1 test data input. Pin with internal pullup device. TDI is clocked into the selected register (instruction or data) on a rising edge of TCK.  |
| TDO                         | O/Z   | IEEE standard 1149.1 test data output. The contents of the selected register (instruction or data) is shifted out of TDO on the falling edge of TCK. TDO is in the high-impedance state except when the scanning of data is in progress. TDO also goes into the high-impedance state when EMU1/ÖFF is low.   |
| TMS                         | I     | IEEE standard 1149.1 test mode select. Pin with internal pullup device. This serial control input is clocked into the TAP controller on the rising edge of TCK.  |
| TRST                        | I     | IEEE standard 1149.1 test reset. $\overline{\text{TRST}}$ , when high, gives the IEEE standard 1149.1 scan system control of the operations of the device. If TRST is not connected or driven low, the device operates in its functional mode, and the IEEE standard 1149.1 signals are ignored. Pin with internal pulldown device.  |
| EMU0                        | I/O/Z | Emulator interrupt 0 pin. When $\overline{\text{TRST}}$ is driven low, EMU0 must be high for the activation of the EMU1/ÖFF condition. When $\overline{\text{TRST}}$ is driven high, EMU0 is used as an interrupt to or from the emulator system and is defined as input/output by way of IEEE standard 1149.1 scan system.  |
| EMU1/ÖFF                    | I/O/Z | Emulator interrupt 1 pin/disable all outputs. When $\overline{\text{TRST}}$ is driven high, EMU1/ÖFF is used as an interrupt to or from the emulator system and is defined as input/output by way of IEEE standard 1149.1 scan system. When $\overline{\text{TRST}}$ is driven low, EMU1/ÖFF is configured as ÖFF. The EMU1/ÖFF signal, when active low, puts all output drivers into the high-impedance state. Note that ÖFF is used exclusively for testing and emulation purposes (not for multiprocessing applications). Therefore, for the ÖFF condition, the following conditions apply:<br>TRST = low,<br>EMU0 = high<br>EMU1/ÖFF = low |
| <b>DEVICE TEST PIN</b>      |       |  |
| TEST1                       | I     | Test1 - Reserved for internal use only. <b>This pin must not be connected (NC).</b>  |

† I = Input, O = Output, Z = High impedance



**absolute maximum ratings over specified temperature range (unless otherwise noted)<sup>†</sup>**

|   |                 |
|---|-----------------|
| Supply voltage, $DV_{DD}$ <sup>‡</sup> .....  | -0.3 V to 4.6 V |
| Input voltage range .....                     | -0.3 V to 4.6 V |
| Output voltage range .....                    | -0.3 V to 4.6 V |
| Operating case temperature range, $T_C$ ..... | -40°C to 100°C  |
| Storage temperature range, $T_{stg}$ .....    | -55°C to 150°C  |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>‡</sup> All voltage values are with respect to  $V_{SS}$ .

**recommended operating conditions**

|           |                            | MIN   | NOM | MAX             | UNIT    |
|-----------|----------------------------|---|-----|-----------------|---------|
| $DV_{DD}$ | Device supply voltage      | 3   | 3.3 | 3.6             | V       |
| $V_{SS}$  | Supply voltage, GND        | 0   |     |                 | V       |
| $V_{IH}$  | High-level input voltage   | Schmitt trigger inputs,<br>$DV_{DD} = 3.3 \pm 0.3$ V <sup>§</sup> |     | $DV_{DD} + 0.3$ | V       |
|           |                            | All other inputs  |     | $DV_{DD} + 0.3$ |         |
| $V_{IL}$  | Low-level input voltage    | -0.3  |     | 0.8             | V       |
| $I_{OH}$  | High-level output current  |   |     | -300            | $\mu$ A |
| $I_{OL}$  | Low-level output current   |   |     | 1.5             | mA      |
| $T_C$     | Operating case temperature | -40   |     | 100             | °C      |

<sup>§</sup> The following pins have schmitt trigger inputs:  $RS$ ,  $INT\bar{n}$ ,  $NMI$ , and  $CLKMDn$

Refer to Figure 1 for 3.3-V device test load circuit values.

**PARAMETER MEASUREMENT INFORMATION**

**timing parameter symbology**

Timing parameter symbols used are created in accordance with JEDEC Standard 100-A. To shorten the symbols, some of the pin names and other related terminology have been abbreviated as follows:

Lowercase subscripts and their meanings:

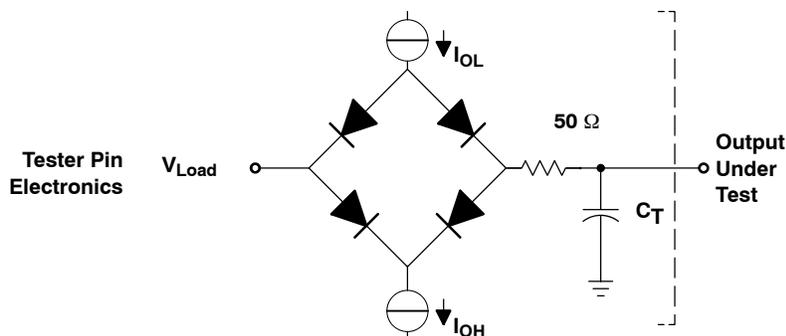
|     |  |
|-----|--|
| a   | access time                            |
| c   | cycle time (period)                    |
| d   | delay time                             |
| dis | disable time                           |
| en  | enable time                            |
| f   | fall time                              |
| h   | hold time                              |
| r   | rise time                              |
| su  | setup time                             |
| t   | transition time                        |
| v   | valid time                             |
| w   | pulse duration (width)                 |
| X   | Unknown, changing, or don't care level |

Letters and symbols and their meanings:

|   |                |
|---|----------------|
| H | High           |
| L | Low            |
| V | Valid          |
| Z | High impedance |

**signal transition reference points**

All timing references are made at a voltage of 1.5 volts, except rise and fall times which are referenced at the 10% and 90% points of the specified low and high logic levels, respectively.



Where:  $I_{OL}$  = 1.5 mA (all outputs)  
 $I_{OH}$  = 300  $\mu$ A (all outputs)  
 $V_{Load}$  = 1.5 V  
 $C_T$  = 40 pF typical load circuit capacitance.

**Figure 1. 3.3-V Test Load Circuit**

**electrical characteristics and operating conditions**

**electrical characteristics over recommended operating case temperature range (unless otherwise noted)**

| PARAMETER        |  | TEST CONDITIONS   | MIN  | TYP <sup>†</sup>  | MAX | UNIT |
|------------------|--|---|--|-------------------|-----|------|
| V <sub>OH</sub>  | High-level output voltage <sup>‡</sup>   | V <sub>DD</sub> = 3.3 ± 0.3 V, I <sub>OH</sub> = MAX                                  | 2.4  |                   |     | V    |
| V <sub>OL</sub>  | Low-level output voltage <sup>‡</sup>  | I <sub>OL</sub> = MAX   |  |                   | 0.4 | V    |
| I <sub>IZ</sub>  | Input current in high impedance  | A[22:0]   | V <sub>DD</sub> = MAX <sup>☆</sup>   | -150              | 250 | μA   |
|                  |  | All other pins  | V <sub>DD</sub> = MAX, V <sub>I</sub> = V <sub>SS</sub> to V <sub>DD</sub> | -10               | 10  |      |
| I <sub>I</sub>   | Input current (V <sub>I</sub> = V <sub>SS</sub> to V <sub>DD</sub> )<br>Input current (V <sub>I</sub> = V <sub>SS</sub> to V <sub>DD</sub> ) | TRST  | With internal pulldown   | -10               | 800 | μA   |
|                  |  | HPIENA  | With internal pulldown, $\overline{RS} = 0$                                | -10               | 400 |      |
|                  |  | TMS, TCK, TDI, HPIII  | With internal pullups  | -400              | 10  |      |
|                  |  | D[15:0], HD[7:0]  | Bus holders enabled, V <sub>DD</sub> = MAX <sup>☆</sup>                    | -150              | 250 |      |
|                  | All other input-only pins  |   |  | -10               | 10  |      |
| I <sub>DDC</sub> | Supply current, core CPU   | V <sub>DD</sub> = 3.3 V, f <sub>x</sub> = 40 MHz, <sup>§</sup> T <sub>C</sub> = 25°C  |  | 28 <sup>¶</sup>   |     | mA   |
| I <sub>DDP</sub> | Supply current, pins   | DV <sub>DD</sub> = 3.3 V, f <sub>x</sub> = 40 MHz, <sup>§</sup> T <sub>C</sub> = 25°C |  | 10.8 <sup>#</sup> |     | mA   |
| I <sub>DD</sub>  | Supply current, standby  | IDLE2   | PLL × 1 mode, 40 MHz input   |                   | 2   | mA   |
|                  |  | IDLE3   | Divide-by-two mode, CLKIN stopped  |                   | 5   | μA   |
| C <sub>i</sub>   | Input capacitance  |   |  | 10                |     | pF   |
| C <sub>o</sub>   | Output capacitance   |   |  | 10                |     | pF   |

<sup>†</sup> All values are typical unless otherwise specified.

<sup>‡</sup> All input and output voltage levels except  $\overline{RS}$ ,  $\overline{INT0}$ - $\overline{INT3}$ ,  $\overline{NMI}$ , CNT, X2/CLKIN, CLKMD0-CLKMD3 are LVTTTL-compatible.

<sup>§</sup> Clock mode: PLL × 1 with external source

<sup>¶</sup> This value was obtained with 50% usage of MAC and 50% usage of NOP instructions. Actual operating current varies with program being executed.

<sup>#</sup> This value was obtained with single-cycle external writes, CLKOFF = 0 and load = 15 pF. For more details on how this calculation is performed, refer to the *Calculation of TMS320C54x Power Dissipation* application report (literature number SPRA164).

<sup>||</sup> HPI input signals except for HPIENA.

<sup>☆</sup> V<sub>IL(MIN)</sub> ≤ V<sub>I</sub> ≤ V<sub>IL(MAX)</sub> or V<sub>IH(MIN)</sub> ≤ V<sub>I</sub> ≤ V<sub>IH(MAX)</sub>

# TMS320LC548 FIXED-POINT DIGITAL SIGNAL PROCESSOR

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## internal oscillator with external crystal

The internal oscillator is enabled by selecting the appropriate clock mode at reset (this is device-dependent – see PLL section) and connecting a crystal or ceramic resonator across X1 and X2/CLKIN. The CPU clock frequency is one-half the crystal’s oscillation frequency following reset. After reset, the clock mode of the devices with the software PLL can also be changed to divide-by-four. Since the internal oscillator can be used as a clock source to the PLL, the crystal oscillation frequency can be multiplied to generate the CPU clock if desired.

The crystal should be in fundamental mode operation and parallel resonant with an effective series resistance of 30ohms and power dissipation of 1 mW. The connection of the required circuit, consisting of the crystal and two load capacitors, is shown in Figure 2. The load capacitors, C<sub>1</sub> and C<sub>2</sub>, should be chosen such that the equation below is satisfied. C<sub>L</sub> in the equation is the load specified for the crystal.

$$C_L = \frac{C_1 C_2}{(C_1 + C_2)}$$

## recommended operating conditions (see Figure 2)

|                                      | '548-66         |     |                 | '548-80         |     |                 | UNIT |
|--------------------------------------|-----------------|-----|-----------------|-----------------|-----|-----------------|------|
|                                      | MIN             | NOM | MAX             | MIN             | NOM | MAX             |      |
| f <sub>x</sub> Input clock frequency | 10 <sup>†</sup> |     | 20 <sup>‡</sup> | 10 <sup>†</sup> |     | 20 <sup>‡</sup> | MHz  |

<sup>†</sup> This device utilizes a fully static design and therefore can operate with t<sub>c(CL)</sub> approaching ∞. The device is characterized at frequencies approaching 0 Hz.

<sup>‡</sup> It is recommended that the PLL clocking option be used for maximum frequency operation.

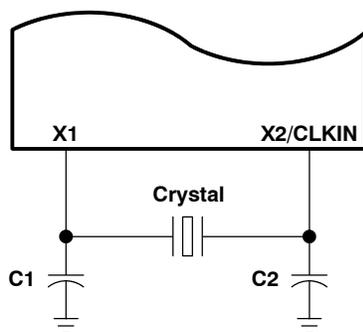


Figure 2. Internal Divide-by-Two Clock Option With External Crystal

**divide-by-two/divide-by-four clock option - PLL disabled**

The frequency of the reference clock provided at the X2/CLKIN pin can be divided by a factor of two or four to generate the internal machine cycle. The selection of the clock mode is described in the clock generator section.

When an external clock source is used, the frequency injected must conform to specifications listed in the timing requirements table.

**switching characteristics over recommended operating conditions [ $H = 0.5t_{c(CO)}$ ] (see Figure 2 and Figure 3, and the recommended operating conditions table)**

| PARAMETER       |  | '548-66         |              |     | '548-80           |              |     | UNIT |
|-----------------|--|-----------------|--------------|-----|-------------------|--------------|-----|------|
|                 |  | MIN             | TYP          | MAX | MIN               | TYP          | MAX |      |
| $t_{c(CO)}$     | Cycle time, CLKOUT                           | 15 <sup>‡</sup> | $2t_{c(CI)}$ | †   | 12.5 <sup>‡</sup> | $2t_{c(CI)}$ | †   | ns   |
| $t_{d(CIH-CO)}$ | Delay time, X2/CLKIN high to CLKOUT high/low | 4               | 10           | 16  | 4                 | 10           | 16  | ns   |
| $t_{f(CO)}$     | Fall time, CLKOUT <sup>†</sup>               | 2               |              |     | 2                 |              |     | ns   |
| $t_{r(CO)}$     | Rise time, CLKOUT <sup>†</sup>               | 2               |              |     | 2                 |              |     | ns   |
| $t_{w(COL)}$    | Pulse duration, CLKOUT low <sup>†</sup>      | H-4             | H-2          | H   | H-3               | H-1          | H   | ns   |
| $t_{w(COH)}$    | Pulse duration, CLKOUT high <sup>†</sup>     | H-4             | H-2          | H   | H-3               | H-1          | H   | ns   |

† This device utilizes a fully static design and therefore can operate with  $t_{c(CI)}$  approaching  $\infty$ . The device is characterized at frequencies approaching 0 Hz.

‡ It is recommended that the PLL clocking option be used for maximum frequency operation.

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## divide-by-two/divide-by-four clock option - PLL disabled (continued)

### timing requirements (see Figure 3)

|  | '548-66         |     | '548-80         |     | UNIT |
|--|-----------------|-----|-----------------|-----|------|
|  | MIN             | MAX | MIN             | MAX |      |
| $t_{c(CI)}$ Cycle time, X2/CLKIN           | 20 <sup>‡</sup> | †   | 20 <sup>‡</sup> | †   | ns   |
| $t_{f(CI)}$ Fall time, X2/CLKIN            |                 | 4   |                 | 2   | ns   |
| $t_{r(CI)}$ Rise time, X2/CLKIN            |                 | 4   |                 | 2   | ns   |
| $t_{w(CIL)}$ Pulse duration, X2/CLKIN low  | 5               | †   | 5               | †   | ns   |
| $t_{w(CIH)}$ Pulse duration, X2/CLKIN high | 5               | †   | 5               | †   | ns   |

† This device utilizes a fully static design and therefore can operate with  $t_{c(CI)}$  approaching  $\infty$ . The device is characterized at frequencies approaching 0 Hz.

‡ It is recommended that the PLL clocking option be used for maximum frequency operation.

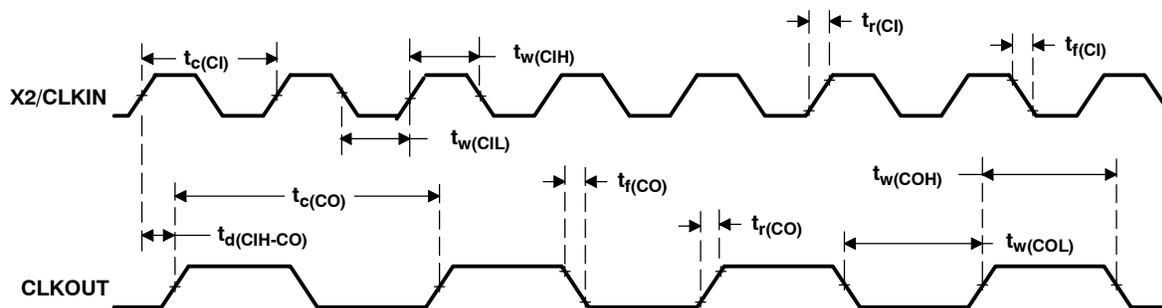


Figure 3. External Divide-by-Two Clock Timing

**multiply-by-N clock option - PLL enabled**

The frequency of the reference clock provided at the X2/CLKIN pin can be multiplied by a factor of N to generate the internal machine cycle. The selection of the clock mode and the value of N is described in the clock generator section.

When an external clock source is used, the frequency injected must conform to specifications listed in the timing requirements table.

**switching characteristics over recommended operating conditions [ $H = 0.5t_{c(CO)}$ ] (see Figure 2 and Figure 4, and the recommended operating conditions table)**

| PARAMETER       |  | '548-66 |               |     | '548-80 |               |     | UNIT    |
|-----------------|--|---------|---------------|-----|---------|---------------|-----|---------|
|                 |  | MIN     | TYP           | MAX | MIN     | TYP           | MAX |         |
| $t_{c(CO)}$     | Cycle time, CLKOUT                               | 15      | $t_{c(CI)}/N$ |     | 12.5    | $t_{c(CI)}/N$ |     | ns      |
| $t_{d(CIH-CO)}$ | Delay time, X2/CLKIN high/low to CLKOUT high/low | 4       | 10            | 16  | 4       | 10            | 16  | ns      |
| $t_{f(CO)}$     | Fall time, CLKOUT                                |         | 2             |     |         | 2             |     | ns      |
| $t_{r(CO)}$     | Rise time, CLKOUT                                |         | 2             |     |         | 2             |     | ns      |
| $t_{w(COL)}$    | Pulse duration, CLKOUT low                       | H-4     | H-2           | H   | H-3     | H-1           | H   | ns      |
| $t_{w(COH)}$    | Pulse duration, CLKOUT high                      | H-4     | H-2           | H   | H-3     | H-1           | H   | ns      |
| $t_p$           | Transitory phase, PLL lock-up time               |         |               | 50  |         |               | 29  | $\mu$ s |

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## multiply-by-N clock option - PLL enabled (continued)

### timing requirements (see Figure 4)

|              |                                     | '548-66         |     | '548-80         |     | UNIT |
|--------------|-------------------------------------|-----------------|-----|-----------------|-----|------|
|              |                                     | MIN             | MAX | MIN             | MAX |      |
| $t_{c(CI)}$  | Cycle time, X2/CLKIN                | 20 <sup>†</sup> | 400 | 20 <sup>†</sup> | 400 | ns   |
|              | Integer PLL multiplier N (N = 1-15) | 20 <sup>†</sup> | 400 | 20 <sup>†</sup> | 400 |      |
|              | PLL multiplier N = x.5              | 20 <sup>†</sup> | 200 | 20 <sup>†</sup> | 200 |      |
|              | PLL multiplier N = x.25, x.75       | 20 <sup>†</sup> | 100 | 20 <sup>†</sup> | 100 |      |
| $t_{f(CI)}$  | Fall time, X2/CLKIN                 |                 | 4   |                 | 2   | ns   |
| $t_{r(CI)}$  | Rise time, X2/CLKIN                 |                 | 4   |                 | 2   | ns   |
| $t_{w(CIL)}$ | Pulse duration, X2/CLKIN low        |                 | 5   |                 | 5   | ns   |
| $t_{w(CIH)}$ | Pulse duration, X2/CLKIN high       |                 | 5   |                 | 5   | ns   |

<sup>†</sup> Note that for all values of  $t_{c(CI)}$ , the minimum  $t_{c(CO)}$  period must not be exceeded.

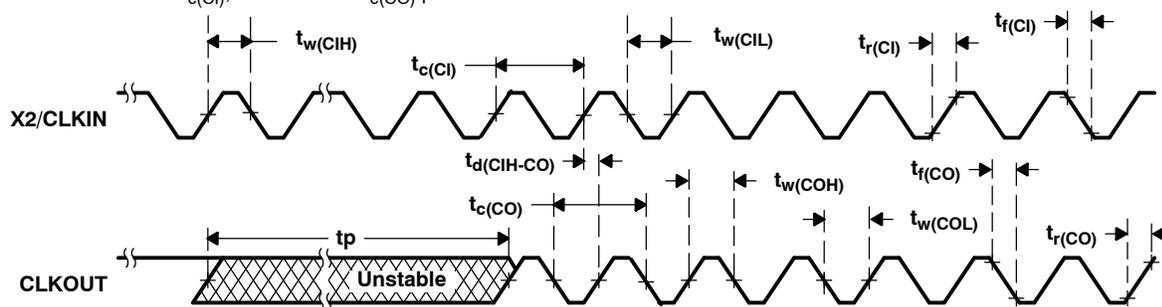


Figure 4. External Multiply-by-One Clock Timing

**memory and parallel I/O interface timing**

**switching characteristics over recommended operating conditions for a memory read ( $\overline{\text{MSTRB}} = 0$ )<sup>†‡</sup> (see Figure 5)**

| PARAMETER                |  | '548-66 |     | '548-80 |     | UNIT |
|--------------------------|--|---------|-----|---------|-----|------|
|                          |  | MIN     | MAX | MIN     | MAX |      |
| $t_{d(\text{CLKL-A})}$   | Delay time, address valid from CLKOUT low <sup>§</sup>               | 0       | 5   | 0       | 6   | ns   |
| $t_{d(\text{CLKH-A})}$   | Delay time, address valid from CLKOUT high (transition) <sup>¶</sup> | - 2     | 3   | 0       | 5   | ns   |
| $t_{d(\text{CLKL-MSL})}$ | Delay time, $\overline{\text{MSTRB}}$ low from CLKOUT low            | 0       | 5   | 0       | 6   | ns   |
| $t_{d(\text{CLKL-MSH})}$ | Delay time, $\overline{\text{MSTRB}}$ high from CLKOUT low           | - 2     | 3   | 0       | 5   | ns   |
| $t_{h(\text{CLKL-A})R}$  | Hold time, address valid after CLKOUT low <sup>§</sup>               | 0       | 5   | 0       | 6   | ns   |
| $t_{h(\text{CLKH-A})R}$  | Hold time, address valid after CLKOUT high <sup>¶</sup>              | - 2     | 3   | 0       | 5   | ns   |

<sup>†</sup> Address,  $\overline{\text{PS}}$ , and  $\overline{\text{DS}}$  timings are all included in timings referenced as address.

<sup>‡</sup> See Table 1, Table 2, and Table 3 for address bus timing variation with load capacitance.

<sup>§</sup> In the case of a memory read preceded by a memory read

<sup>¶</sup> In the case of a memory read preceded by a memory write

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## memory and parallel I/O interface timing (continued)

### timing requirements for a memory read ( $\overline{\text{MSTRB}} = 0$ ) [ $H = 0.5 t_{c(CO)}$ ]<sup>†‡</sup> (see Figure 5)

|                  |  | '548-66 |     | '548-80 |     | UNIT |
|------------------|--|---------|-----|---------|-----|------|
|                  |  | MIN     | MAX | MIN     | MAX |      |
| $t_{a(A)M}$      | Access time, read data access from address valid                 | 2H-10   |     | 2H-7.5  |     | ns   |
| $t_{a(MSTRBL)}$  | Access time, read data access from $\overline{\text{MSTRB}}$ low | 2H-10   |     | 2H-7.5  |     | ns   |
| $t_{su(D)R}$     | Setup time, read data before CLKOUT low                          | 5       |     | 5       |     | ns   |
| $t_{h(D)R}$      | Hold time, read data after CLKOUT low                            | 2       |     | 2       |     | ns   |
| $t_{h(A-D)R}$    | Hold time, read data after address invalid                       | 1       |     | 1       |     | ns   |
| $t_{h(D)MSTRBH}$ | Hold time, read data after $\overline{\text{MSTRB}}$ high        | 0       |     | 0       |     | ns   |

<sup>†</sup> Address,  $\overline{\text{PS}}$ , and  $\overline{\text{DS}}$  timings are all included in timings referenced as address.

<sup>‡</sup> See Table 1, Table 2, and Table 3 for address bus timing variation with load capacitance.



memory and parallel I/O interface timing (continued)

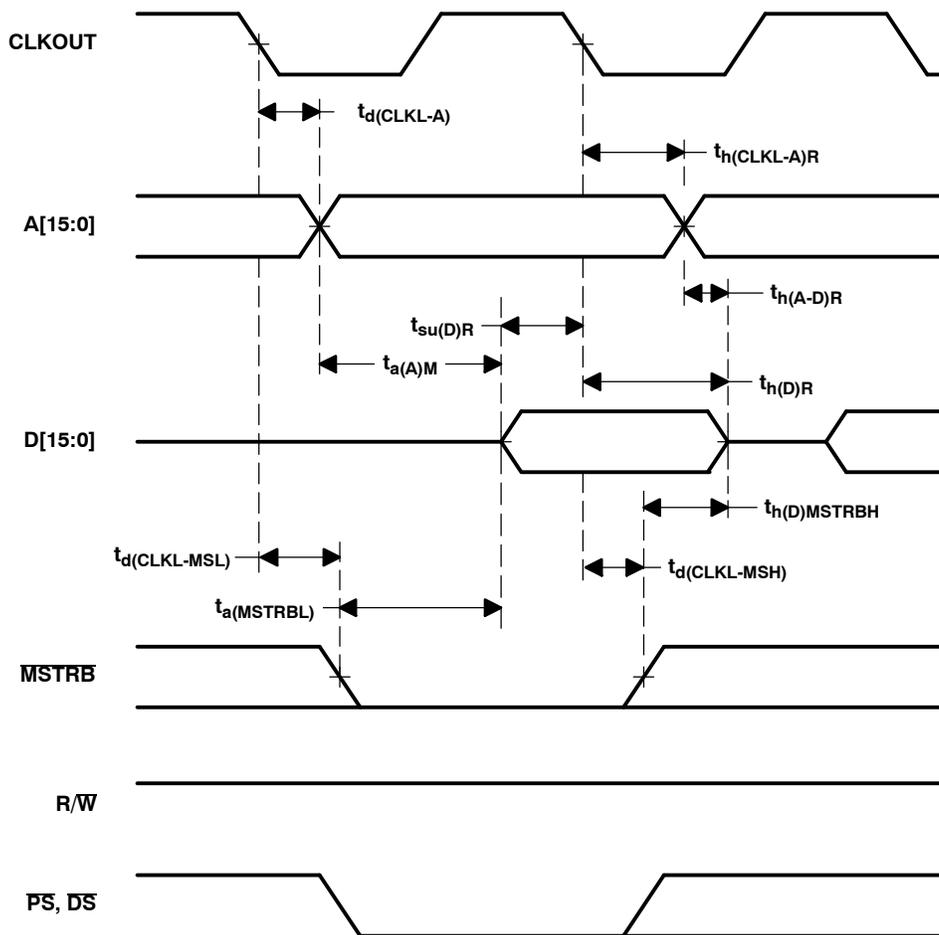


Figure 5. Memory Read ( $\overline{\text{MSTRB}} = 0$ )

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## memory and parallel I/O interface timing (continued)

switching characteristics over recommended operating conditions for a memory write ( $\overline{\text{MSTRB}} = 0$ ) [ $H = 0.5 t_{c(CO)}$ ]<sup>†‡</sup> (see Figure 6)

| PARAMETER                  |  | '548-66 |                   | '548-80 |                   | UNIT |
|----------------------------|--|---------|-------------------|---------|-------------------|------|
|                            |  | MIN     | MAX               | MIN     | MAX               |      |
| $t_{d(\text{CLKH-A})}$     | Delay time, address valid from CLKOUT high <sup>§</sup>              | - 2     | 3                 | 0       | 5                 | ns   |
| $t_{d(\text{CLKL-A})}$     | Delay time, address valid from CLKOUT low <sup>¶</sup>               | 0       | 5                 | 0       | 6                 | ns   |
| $t_{d(\text{CLKL-MSL})}$   | Delay time, $\overline{\text{MSTRB}}$ low from CLKOUT low            | 0       | 5                 | 0       | 6                 | ns   |
| $t_{d(\text{CLKL-D})W}$    | Delay time, data valid from CLKOUT low                               | 0       | 6                 | 0       | 7                 | ns   |
| $t_{d(\text{CLKL-MSH})}$   | Delay time, $\overline{\text{MSTRB}}$ high from CLKOUT low           | - 2     | 3                 | 0       | 5                 | ns   |
| $t_{d(\text{CLKH-RWL})}$   | Delay time, $R/\overline{W}$ low from CLKOUT high                    | - 2     | 3                 | - 1     | 4                 | ns   |
| $t_{d(\text{CLKH-RWH})}$   | Delay time, $R/\overline{W}$ high from CLKOUT high                   | - 2     | 3                 | - 1     | 4                 | ns   |
| $t_{d(\text{RWL-MSTRBL})}$ | Delay time, $\overline{\text{MSTRB}}$ low after $R/\overline{W}$ low | H - 2   | H + 3             | H - 2   | H + 2             | ns   |
| $t_{h(A)W}$                | Hold time, address valid after CLKOUT high <sup>§</sup>              | 0       | 5                 | - 1     | 5                 | ns   |
| $t_{h(D)MSH}$              | Hold time, write data valid after $\overline{\text{MSTRB}}$ high     | H-5     | H+5 <sup>¶</sup>  | H-4     | H+4 <sup>¶</sup>  | ns   |
| $t_w(\text{SL})MS$         | Pulse duration, $\overline{\text{MSTRB}}$ low                        | 2H-5    |                   | 2H-5    |                   | ns   |
| $t_{su(A)W}$               | Setup time, address valid before $\overline{\text{MSTRB}}$ low       | 2H-5    |                   | 2H-5    |                   | ns   |
| $t_{su(D)MSH}$             | Setup time, write data valid before $\overline{\text{MSTRB}}$ high   | 2H-10   | 2H+8 <sup>§</sup> | 2H-7    | 2H+7 <sup>¶</sup> | ns   |

<sup>†</sup> Address,  $\overline{\text{PS}}$ , and  $\overline{\text{DS}}$  timings are all included in timings referenced as address.

<sup>‡</sup> See Table 1, Table 2, and Table 3 for address bus timing variation with load capacitance.

<sup>§</sup> In the case of a memory write preceded by a memory write.

<sup>¶</sup> In the case of a memory write preceded by an I/O cycle.



memory and parallel I/O interface timing (continued)

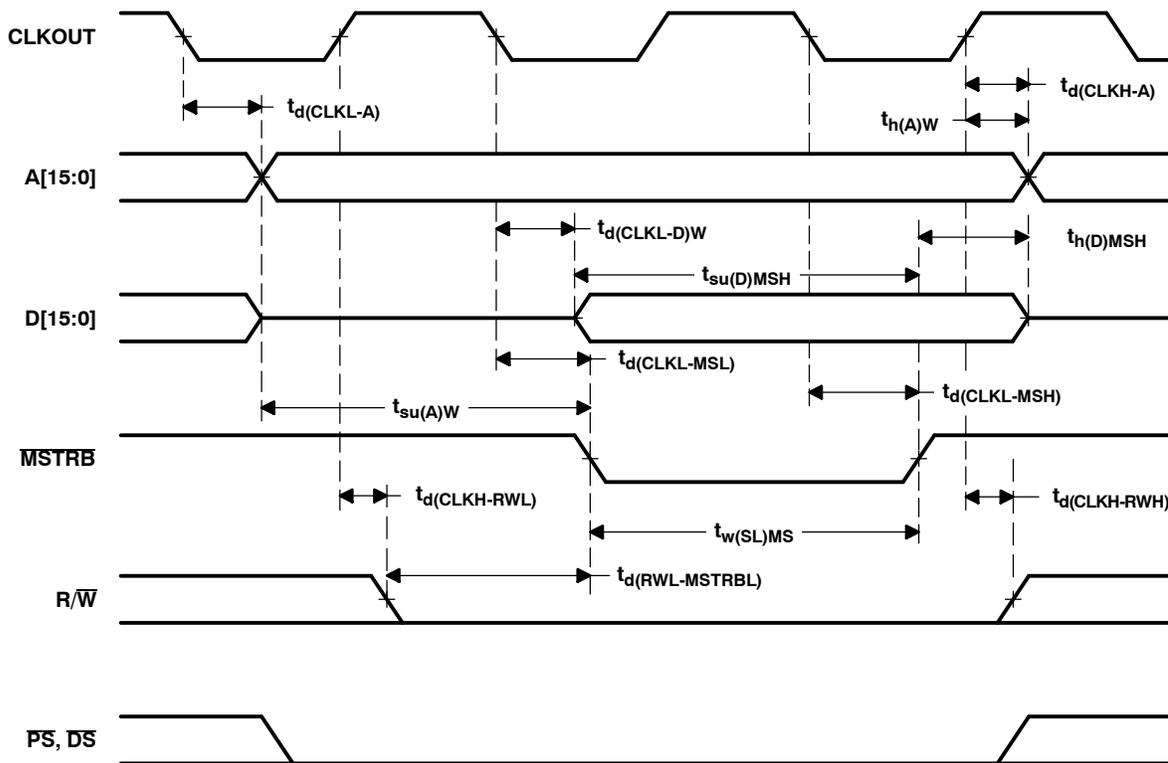


Figure 6. Memory Write ( $\overline{MSTRB} = 0$ )

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## memory and parallel I/O interface timing (continued)

switching characteristics over recommended operating conditions for a parallel I/O port read ( $\overline{\text{IOSTRB}} = 0$ )<sup>†‡</sup> (see Figure 7)

| PARAMETER                   |  | '548-66 |     | '548-80 |     | UNIT |
|-----------------------------|--|---------|-----|---------|-----|------|
|                             |  | MIN     | MAX | MIN     | MAX |      |
| $t_{d(\text{CLKL-A})}$      | Delay time, address valid from CLKOUT low                    | 0       | 5   | 0       | 6   | ns   |
| $t_{d(\text{CLKH-ISTRBL})}$ | Delay time, $\overline{\text{IOSTRB}}$ low from CLKOUT high  | - 2     | 3   | - 1     | 4   | ns   |
| $t_{d(\text{CLKH-ISTRBH})}$ | Delay time, $\overline{\text{IOSTRB}}$ high from CLKOUT high | - 2     | 3   | - 1     | 4   | ns   |
| $t_{h(A)\text{IOR}}$        | Hold time, address after CLKOUT low                          | 0       | 5   | 0       | 6   | ns   |

<sup>†</sup> Address and  $\overline{\text{IS}}$  timings are included in timings referenced as address.

<sup>‡</sup> See Table 1, Table 2, and Table 3 for address bus timing variation with load capacitance.



memory and parallel I/O interface timing (continued)

timing requirements for a parallel I/O port read ( $\overline{\text{IOSTRB}} = 0$ ) [ $H = 0.5 t_{c(\text{CO})}$ ]<sup>†‡</sup> (see Figure 7)

|  |   | '548-66 |       | '548-80 |      | UNIT |
|--|---|---------|-------|---------|------|------|
|  |   | MIN     | MAX   | MIN     | MAX  |      |
| $t_{a(\text{A})\text{IO}}$               | Access time, read data access from address valid                  |         | 3H-10 |         | 3H-5 | ns   |
| $t_{a(\text{IOSTRBL})\text{IO}}$         | Access time, read data access from $\overline{\text{IOSTRB}}$ low |         | 2H-10 |         | 2H-5 | ns   |
| $t_{\text{su}(\text{D})\text{IOR}}$      | Setup time, read data before CLKOUT high                          | 5       |       | 4       |      | ns   |
| $t_{\text{h}(\text{D})\text{IOR}}$       | Hold time, read data after CLKOUT high                            | 2       |       | 2       |      | ns   |
| $t_{\text{h}(\text{IOSTRBH-D})\text{R}}$ | Hold time, read data after $\overline{\text{IOSTRB}}$ high        | 0       |       | 0       |      | ns   |

<sup>†</sup> Address and  $\overline{\text{IS}}$  timings are included in timings referenced as address.

<sup>‡</sup> See Table 1, Table 2, and Table 3 for address bus timing variation with load capacitance.

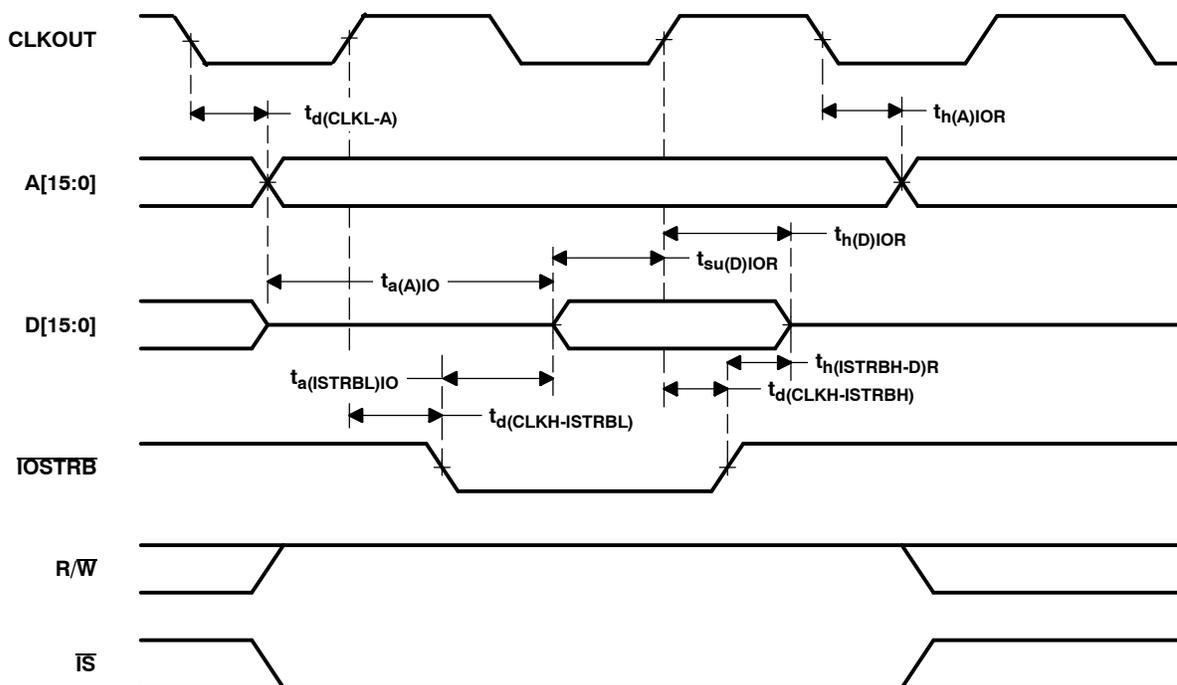


Figure 7. Parallel I/O Port Read ( $\overline{\text{IOSTRB}} = 0$ )

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## memory and parallel I/O interface timing (continued)

switching characteristics over recommended operating conditions for a parallel I/O port write ( $\overline{\text{IOSTRB}} = 0$ ) [ $H = 0.5 t_{c(CO)}$ ] (see Figure 8)<sup>†</sup>

| PARAMETER                        |   | '548-66 |     | '548-80 |     | UNIT |
|----------------------------------|---|---------|-----|---------|-----|------|
|                                  |   | MIN     | MAX | MIN     | MAX |      |
| $t_{d(\text{CLKL-A})}$           | Delay time, address valid from CLKOUT low <sup>‡</sup>          | 0       | 5   | 0       | 6   | ns   |
| $t_{d(\text{CLKH-ISTRBL})}$      | Delay time, $\overline{\text{IOSTRB}}$ low from CLKOUT high     | - 2     | 3   | - 1     | 4   | ns   |
| $t_{d(\text{CLKH-D})\text{IOW}}$ | Delay time, write data valid from CLKOUT high                   | H-5     | H+8 | H-5     | H+6 | ns   |
| $t_{d(\text{CLKH-ISTRBH})}$      | Delay time, $\overline{\text{IOSTRB}}$ high from CLKOUT high    | - 2     | 3   | - 1     | 4   | ns   |
| $t_{d(\text{CLKL-RWL})}$         | Delay time, R/ $\overline{\text{W}}$ low from CLKOUT low        | 0       | 5   | 0       | 4   | ns   |
| $t_{d(\text{CLKL-RWH})}$         | Delay time, R/ $\overline{\text{W}}$ high from CLKOUT low       | - 2     | 3   | 0       | 5   | ns   |
| $t_{h(\text{A})\text{IOW}}$      | Hold time, address valid from CLKOUT low <sup>‡</sup>           | 0       | 5   | 0       | 6   | ns   |
| $t_{h(\text{D})\text{IOW}}$      | Hold time, write data after $\overline{\text{IOSTRB}}$ high     | H-5     | H+5 | H-4     | H+4 | ns   |
| $t_{su(\text{D})\text{IOSTRBH}}$ | Setup time, write data before $\overline{\text{IOSTRB}}$ high   | H-5     | H   | H-4     | H+1 | ns   |
| $t_{su(\text{A})\text{IOSTRBL}}$ | Setup time, address valid before $\overline{\text{IOSTRB}}$ low | H-5     | H+5 | H-5     | H+5 | ns   |

<sup>†</sup> See Table 1, Table 2, and Table 3 for address bus timing variation with load capacitance.

<sup>‡</sup> Address and  $\overline{\text{IS}}$  timings are included in timings referenced as address.



memory and parallel I/O interface timing (continued)

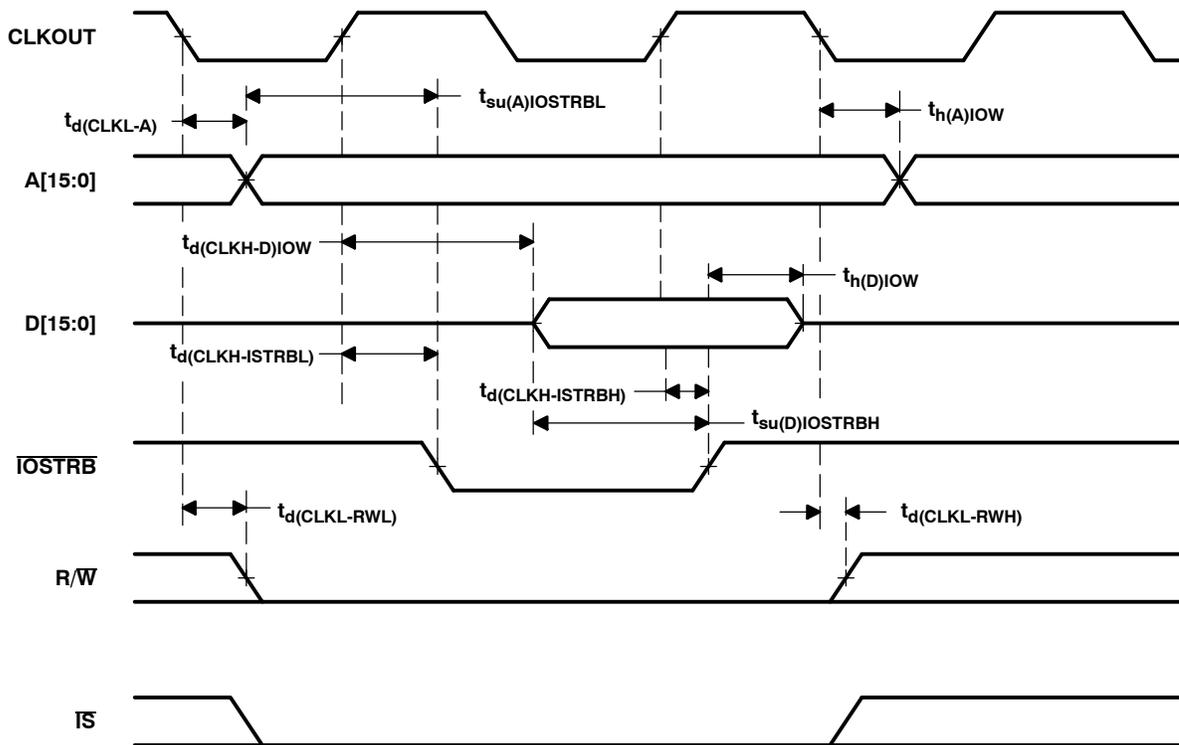


Figure 8. Parallel I/O Port Write ( $\overline{\text{IOSTRB}} = 0$ )

I/O timing variation with load capacitance: SPICE simulation results

Condition: Temperature : 125° C  
 Capacitance : 0-100pF  
 Voltage : 2.7/3.0/3.3 V  
 Model : Weak/Nominal/Strong



Figure 9. Rise and Fall Time Diagram

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## I/O timing variation with load capacitance: SPICE simulation results (continued)

**Table 1. Timing Variation With Load Capacitance: [2.7 V] 10% - 90%**

|        | WEAK      |          | NOMINAL   |          | STRONG   |          |
|--------|-----------|----------|-----------|----------|----------|----------|
|        | RISE      | FALL     | RISE      | FALL     | RISE     | FALL     |
| 0 pF   | 0.476 ns  | 0.457 ns | 0.429 ns  | 0.391 ns | 0.382 ns | 0.323 ns |
| 10 pF  | 1.511 ns  | 1.278 ns | 1.386 ns  | 1.148 ns | 1.215 ns | 1.049 ns |
| 20 pF  | 2.551 ns  | 2.133 ns | 2.350 ns  | 1.956 ns | 2.074 ns | 1.779 ns |
| 30 pF  | 3.614 ns  | 3.011 ns | 3.327 ns  | 2.762 ns | 2.929 ns | 2.512 ns |
| 40 pF  | 4.664 ns  | 3.899 ns | 4.394 ns  | 3.566 ns | 3.798 ns | 3.264 ns |
| 50 pF  | 5.752 ns  | 4.786 ns | 5.273 ns  | 4.395 ns | 4.655 ns | 4.010 ns |
| 60 pF  | 6.789 ns  | 5.656 ns | 6.273 ns  | 5.206 ns | 5.515 ns | 4.750 ns |
| 70 pF  | 7.817 ns  | 6.598 ns | 7.241 ns  | 6.000 ns | 6.442 ns | 5.487 ns |
| 80 pF  | 8.897 ns  | 7.531 ns | 8.278 ns  | 6.928 ns | 7.262 ns | 6.317 ns |
| 90 pF  | 10.021 ns | 8.332 ns | 9.152 ns  | 7.735 ns | 8.130 ns | 7.066 ns |
| 100 pF | 11.072 ns | 9.299 ns | 10.208 ns | 8.537 ns | 8.997 ns | 7.754 ns |

**Table 2. Timing Variation With Load Capacitance: [3 V] 10% - 90%**

|        | WEAK     |          | NOMINAL  |          | STRONG   |          |
|--------|----------|----------|----------|----------|----------|----------|
|        | RISE     | FALL     | RISE     | FALL     | RISE     | FALL     |
| 0 pF   | 0.436 ns | 0.387 ns | 0.398 ns | 0.350 ns | 0.345 ns | 0.290 ns |
| 10 pF  | 1.349 ns | 1.185 ns | 1.240 ns | 1.064 ns | 1.092 ns | 0.964 ns |
| 20 pF  | 2.273 ns | 1.966 ns | 2.098 ns | 1.794 ns | 1.861 ns | 1.634 ns |
| 30 pF  | 3.226 ns | 2.765 ns | 2.974 ns | 2.539 ns | 2.637 ns | 2.324 ns |
| 40 pF  | 4.168 ns | 3.573 ns | 3.849 ns | 3.292 ns | 3.406 ns | 3.013 ns |
| 50 pF  | 5.110 ns | 4.377 ns | 4.732 ns | 4.052 ns | 4.194 ns | 3.710 ns |
| 60 pF  | 6.033 ns | 5.230 ns | 5.660 ns | 4.811 ns | 5.005 ns | 4.401 ns |
| 70 pF  | 7.077 ns | 5.997 ns | 6.524 ns | 5.601 ns | 5.746 ns | 5.117 ns |
| 80 pF  | 8.020 ns | 6.899 ns | 7.416 ns | 6.336 ns | 6.559 ns | 5.861 ns |
| 90 pF  | 8.917 ns | 7.709 ns | 8.218 ns | 7.124 ns | 7.323 ns | 6.498 ns |
| 100 pF | 9.885 ns | 8.541 ns | 9.141 ns | 7.830 ns | 8.101 ns | 7.238 ns |



**I/O timing variation with load capacitance: SPICE simulation results (continued)**

**Table 3. Timing Variation With Load Capacitance: [3.3 V] 10% - 90% [3 V] 10% - 90%**

|        | WEAK     |          | NOMINAL  |          | STRONG   |          |
|--------|----------|----------|----------|----------|----------|----------|
|        | RISE     | FALL     | RISE     | FALL     | RISE     | FALL     |
| 0 pF   | 0.404 ns | 0.361 ns | 0.371 ns | 0.310 ns | 0.321 ns | 0.284 ns |
| 10 pF  | 1.227 ns | 1.081 ns | 1.133 ns | 1.001 ns | 1.000 ns | 0.892 ns |
| 20 pF  | 2.070 ns | 1.822 ns | 1.915 ns | 1.675 ns | 1.704 ns | 1.530 ns |
| 30 pF  | 2.931 ns | 2.567 ns | 2.719 ns | 2.367 ns | 2.414 ns | 2.169 ns |
| 40 pF  | 3.777 ns | 3.322 ns | 3.515 ns | 3.072 ns | 3.120 ns | 2.823 ns |
| 50 pF  | 4.646 ns | 4.091 ns | 4.319 ns | 3.779 ns | 3.842 ns | 3.466 ns |
| 60 pF  | 5.487 ns | 4.859 ns | 5.145 ns | 4.503 ns | 4.571 ns | 4.142 ns |
| 70 pF  | 6.405 ns | 5.608 ns | 5.980 ns | 5.234 ns | 5.301 ns | 4.767 ns |
| 80 pF  | 7.284 ns | 6.463 ns | 6.723 ns | 5.873 ns | 5.941 ns | 5.446 ns |
| 90 pF  | 8.159 ns | 7.097 ns | 7.560 ns | 6.692 ns | 6.740 ns | 6.146 ns |
| 100 pF | 8.994 ns | 7.935 ns | 8.300 ns | 7.307 ns | 7.431 ns | 6.822 ns |

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## ready timing for externally generated wait states

timing requirements for externally generated wait states [ $H = 0.5 t_{c(CO)}$ ]<sup>†</sup> (see Figure 10, Figure 11, Figure 12, and Figure 13)

|                  |  | '548-66 |       | '548-80 |       | UNIT |
|------------------|--|---------|-------|---------|-------|------|
|                  |  | MIN     | MAX   | MIN     | MAX   |      |
| $t_{su}(RDY)$    | Setup time, READY before CLKOUT low                          | 7       |       | 6       |       | ns   |
| $t_h(RDY)$       | Hold time, READY after CLKOUT low                            | 0       |       | 0       |       | ns   |
| $t_v(RDY)MSTRB$  | Valid time, READY after $\overline{MSTRB}$ low <sup>‡</sup>  |         | 4H-10 |         | 4H-10 | ns   |
| $t_h(RDY)MSTRB$  | Hold time, READY after $\overline{MSTRB}$ low <sup>‡</sup>   | 4H      |       | 4H      |       | ns   |
| $t_v(RDY)IOSTRB$ | Valid time, READY after $\overline{IOSTRB}$ low <sup>‡</sup> |         | 5H-10 |         | 5H-10 | ns   |
| $t_h(RDY)IOSTRB$ | Hold time, READY after $\overline{IOSTRB}$ low <sup>‡</sup>  | 5H      |       | 5H      |       | ns   |
| $t_v(MSCL)$      | Valid time, $\overline{MSC}$ low after CLKOUT low            | 0       | 5     | 0       | 4     | ns   |
| $t_v(MSCH)$      | Valid time, $\overline{MSC}$ high after CLKOUT low           | - 2     | 3     | 0       | 4     | ns   |

<sup>†</sup> The hardware wait states can be used only in conjunction with the software wait states to extend the bus cycles. To generate wait states by READY, at least two software wait states must be programmed. READY is not sampled until the completion of the internal software wait states.

<sup>‡</sup> These timings are included for reference only. The critical timings for READY are those referenced to CLKOUT.



ready timing for externally generated wait states (continued)

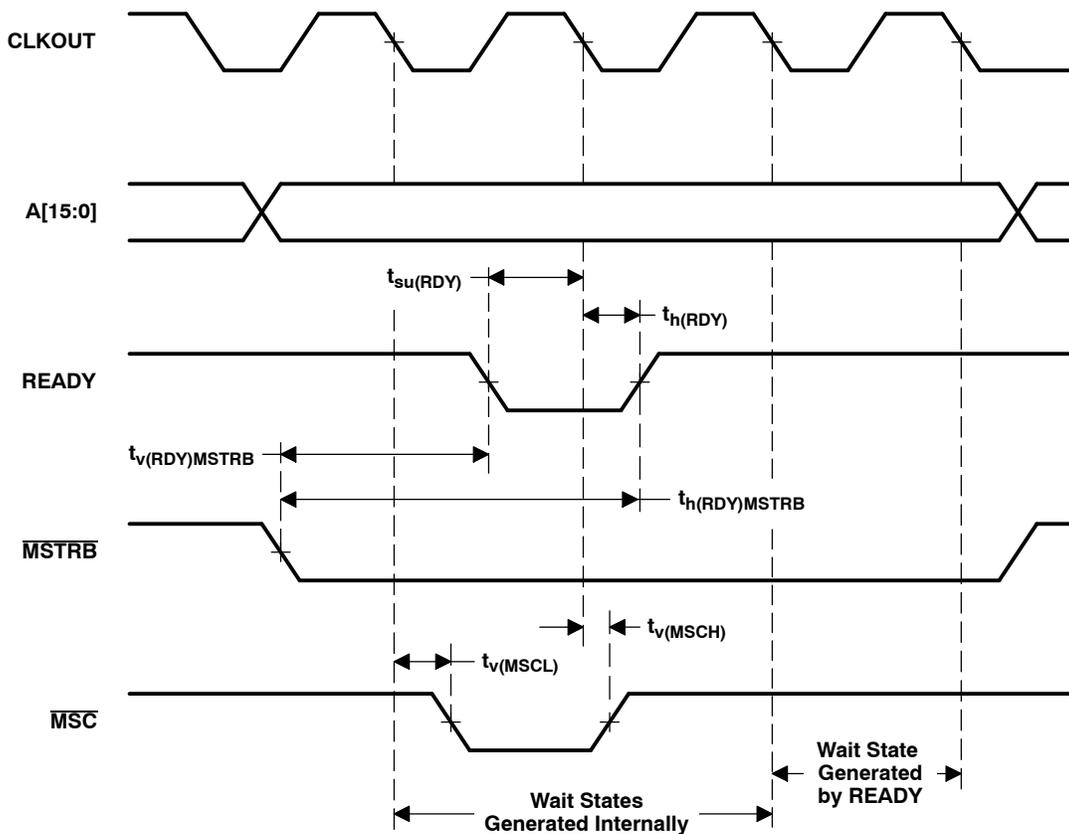


Figure 10. Memory Read With Externally Generated Wait States

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## ready timing for externally generated wait states (continued)

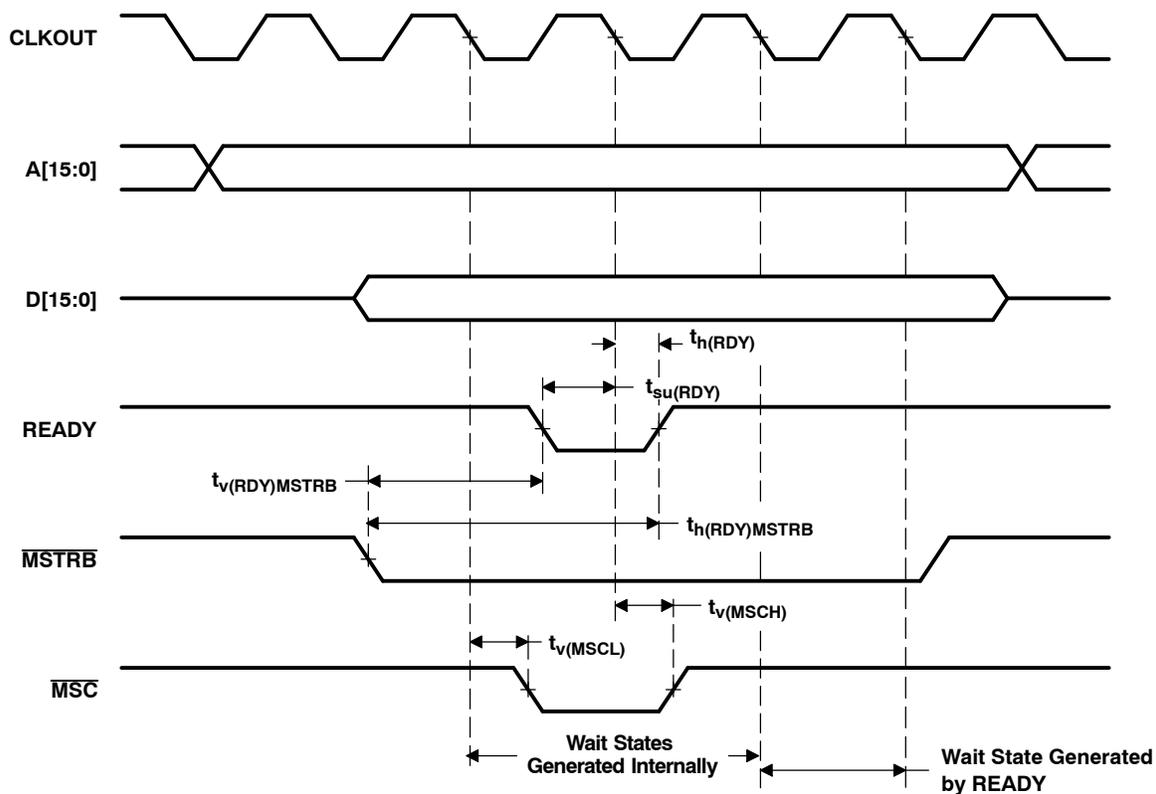


Figure 11. Memory Write With Externally Generated Wait States

ready timing for externally generated wait states (continued)

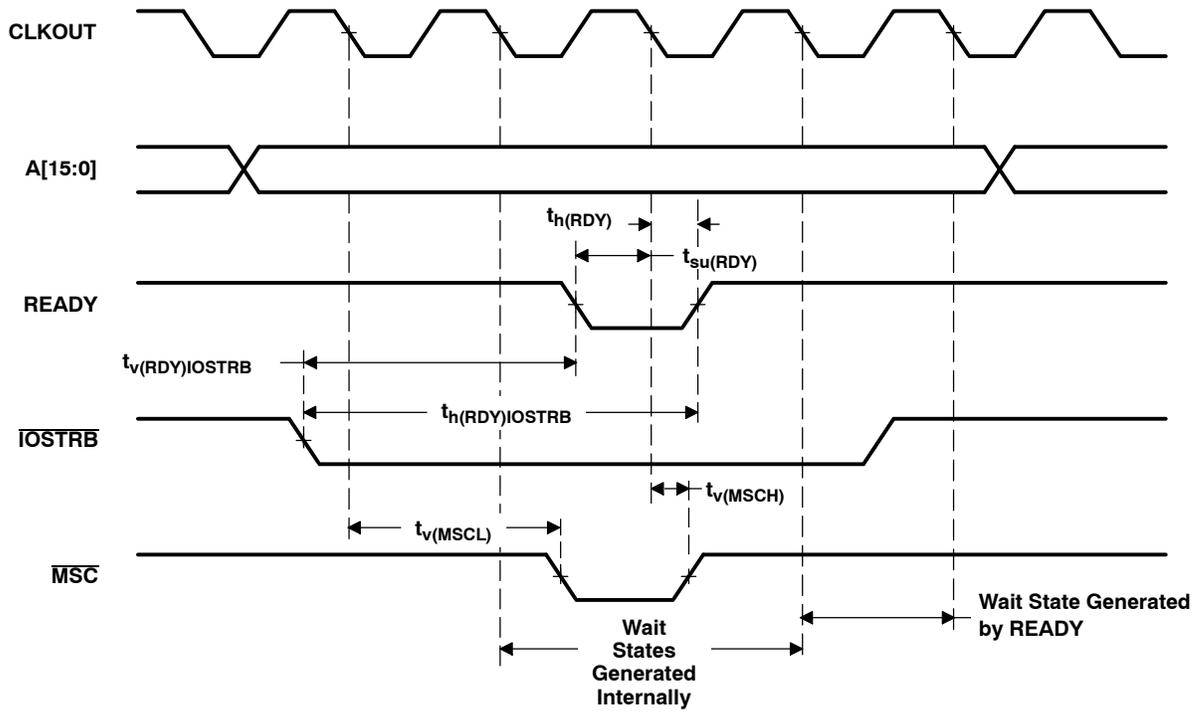


Figure 12. I/O Read With Externally Generated Wait States

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## ready timing for externally generated wait states (continued)

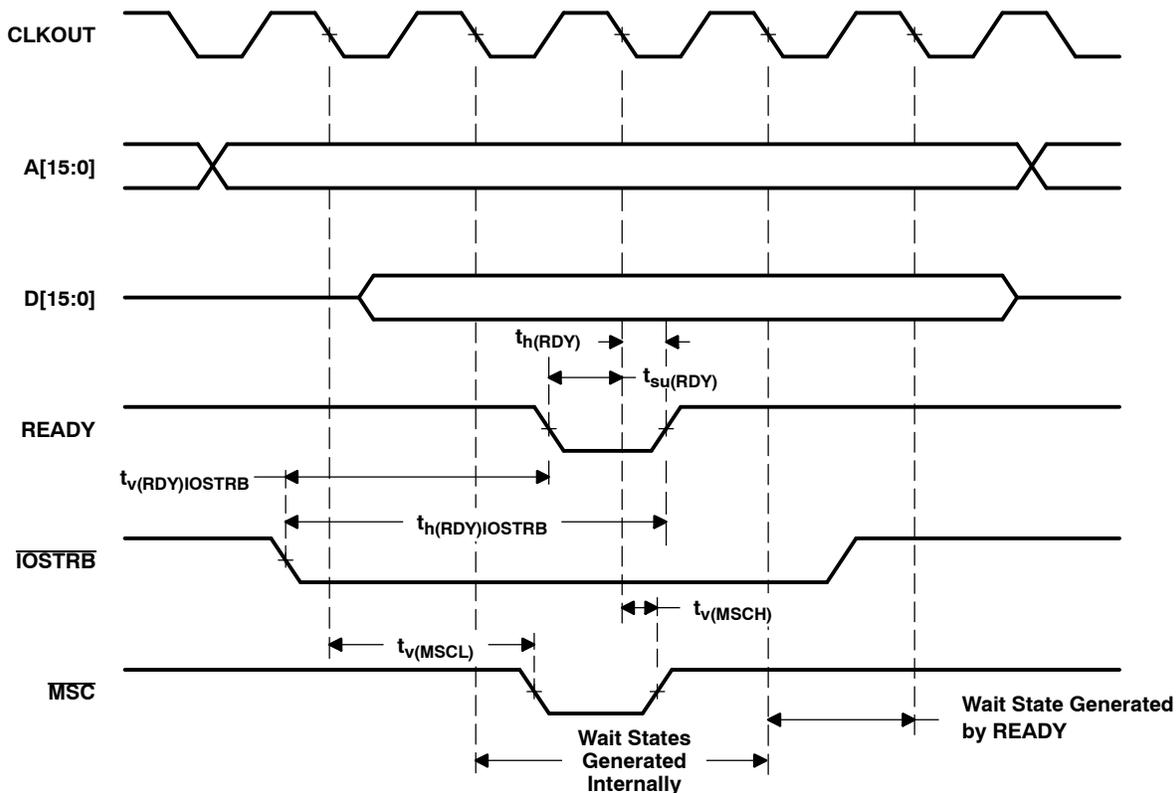


Figure 13. I/O Write With Externally Generated Wait States

**HOLD and HOLDA timings**

**switching characteristics over recommended operating conditions for memory control signals and HOLDA [H = 0.5 t<sub>c(CO)</sub>] (see Figure 14)**

| PARAMETER                 |   | '548-66 |      | '548-80 |      | UNIT |
|---------------------------|---|---------|------|---------|------|------|
|                           |   | MIN     | MAX  | MIN     | MAX  |      |
| t <sub>dis(CLKL-A)</sub>  | Disable time, CLKOUT low to address, $\overline{PS}$ , $\overline{DS}$ , $\overline{TS}$ high impedance |         | 5    | 5       |      | ns   |
| t <sub>dis(CLKL-RW)</sub> | Disable time, CLKOUT low to R/ $\overline{W}$ high impedance  |         | 5    | 5       |      | ns   |
| t <sub>dis(CLKL-S)</sub>  | Disable time, CLKOUT low to $\overline{MSTRB}$ , $\overline{IOSTRB}$ high impedance                     |         | 5    | 5       |      | ns   |
| t <sub>en(CLKL-A)</sub>   | Enable time, CLKOUT low to address, $\overline{PS}$ , $\overline{DS}$ , $\overline{TS}$                 |         | 2H+5 | 2H+5    |      | ns   |
| t <sub>en(CLKL-RW)</sub>  | Enable time, CLKOUT low to R/ $\overline{W}$ enabled  |         | 2H+5 | 2H+5    |      | ns   |
| t <sub>en(CLKL-S)</sub>   | Enable time, CLKOUT low to $\overline{MSTRB}$ , $\overline{IOSTRB}$ enabled                             |         | 2H+5 | 2       | 2H+5 | ns   |
| t <sub>v(HOLDA)</sub>     | Valid time, $\overline{HOLDA}$ low after CLKOUT low   | 0       | 5    | 0       | 5    | ns   |
|                           | Valid time, $\overline{HOLDA}$ high after CLKOUT low  | - 2     | 3    | 0       | 4    | ns   |
| t <sub>w(HOLDA)</sub>     | Pulse duration, $\overline{HOLDA}$ low duration   |         | 2H-3 | 2H-3    |      | ns   |

**timing requirements for HOLD [H = 0.5 t<sub>c(CO)</sub>] (see Figure 14)**

|                       |   | '548-66 |       | '548-80 |     | UNIT |
|-----------------------|---|---------|-------|---------|-----|------|
|                       |   | MIN     | MAX   | MIN     | MAX |      |
| t <sub>w(HOLD)</sub>  | Pulse duration, $\overline{HOLD}$ low duration  |         | 4H+10 | 4H+10   |     | ns   |
| t <sub>su(HOLD)</sub> | Setup time, $\overline{HOLD}$ before CLKOUT low |         | 10    | 10      |     | ns   |

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## HOLD and HOLDA timings (continued)

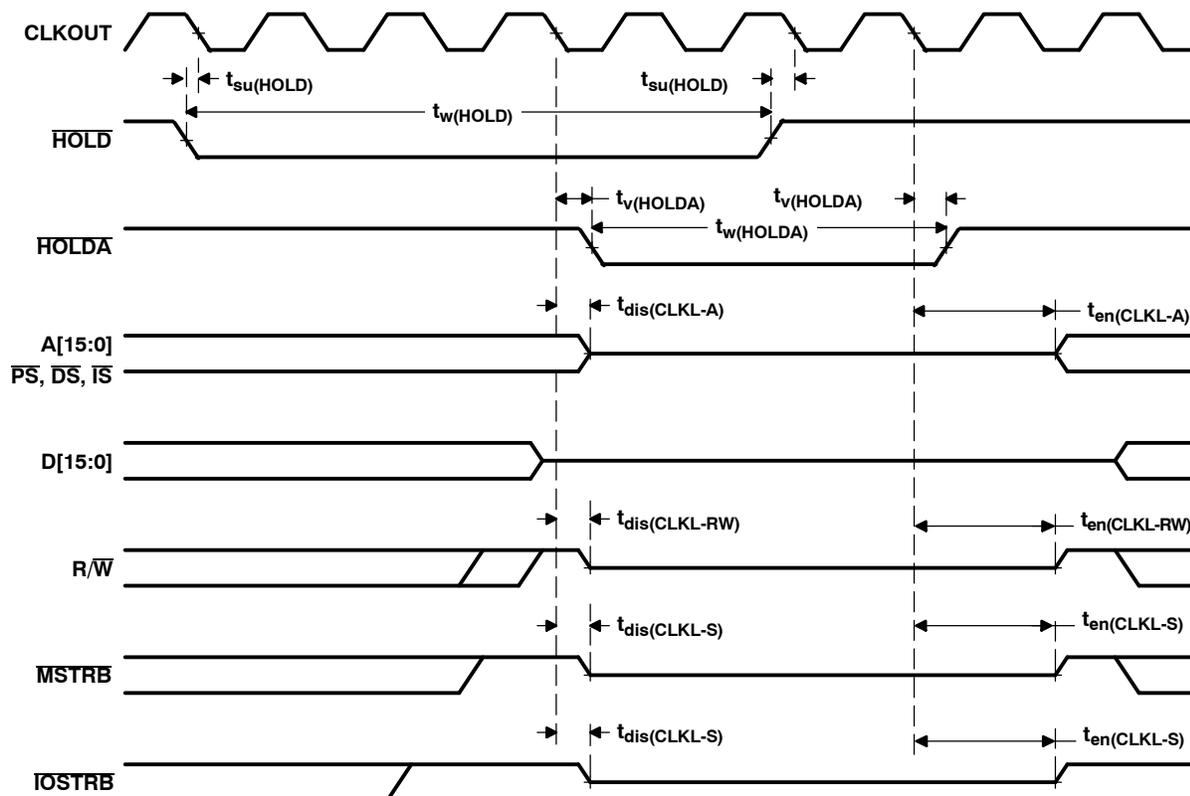


Figure 14. HOLD and HOLDA Timing (HM = 1)

**reset,  $\overline{\text{BIO}}$ , interrupt, and  $\text{MP}/\overline{\text{MC}}$  timings**

**timing requirements for reset, interrupt,  $\overline{\text{BIO}}$ , and  $\text{MP}/\overline{\text{MC}}$  [ $H = 0.5 t_{c(\text{CO})}$ ] (see Figure 15, Figure 16, and Figure 17)**

|                                |   | '548-66 |     | '548-80 |     | UNIT |
|--------------------------------|---|---------|-----|---------|-----|------|
|                                |   | MIN     | MAX | MIN     | MAX |      |
| $t_{h(\text{RS})}$             | Hold time, $\overline{\text{RS}}$ after CLKOUT low  | 0       |     | 0       |     | ns   |
| $t_{h(\text{BIO})}$            | Hold time, $\overline{\text{BIO}}$ after CLKOUT low   | 0       |     | 0       |     | ns   |
| $t_{h(\text{INT})}$            | Hold time, $\overline{\text{INTn}}$ , $\overline{\text{NMI}}$ , after CLKOUT low <sup>†</sup>             | 0       |     | 0       |     | ns   |
| $t_{h(\text{MPMC})}$           | Hold time, $\text{MP}/\overline{\text{MC}}$ after CLKOUT low  | 0       |     | 0       |     | ns   |
| $t_{w(\text{RSL})}$            | Pulse duration, $\overline{\text{RS}}$ low <sup>‡§¶</sup>   | 4H+10   |     | 4H+7    |     | ns   |
| $t_{w(\text{BIO})\text{S}}$    | Pulse duration, $\overline{\text{BIO}}$ low, synchronous  | 2H+10   |     | 2H+7    |     | ns   |
| $t_{w(\text{BIO})\text{A}}$    | Pulse duration, $\overline{\text{BIO}}$ low, asynchronous   | 4H      |     | 4H      |     | ns   |
| $t_{w(\text{INTH})\text{S}}$   | Pulse duration, $\overline{\text{INTn}}$ , $\overline{\text{NMI}}$ high (synchronous)                     | 2H+10   |     | 2H+7    |     | ns   |
| $t_{w(\text{INTH})\text{A}}$   | Pulse duration, $\overline{\text{INTn}}$ , $\overline{\text{NMI}}$ high (asynchronous)                    | 4H      |     | 4H      |     | ns   |
| $t_{w(\text{INTL})\text{S}}$   | Pulse duration, $\overline{\text{INTn}}$ , $\overline{\text{NMI}}$ low (synchronous)                      | 2H+10   |     | 2H+7    |     | ns   |
| $t_{w(\text{INTL})\text{A}}$   | Pulse duration, $\overline{\text{INTn}}$ , $\overline{\text{NMI}}$ low (asynchronous)                     | 4H      |     | 4H      |     | ns   |
| $t_{w(\text{INTL})\text{WKP}}$ | Pulse duration, $\overline{\text{INTn}}$ , $\overline{\text{NMI}}$ low for IDLE2/IDLE3 wakeup             | 10      |     | 10      |     | ns   |
| $t_{\text{su}}(\text{RS})$     | Setup time, $\overline{\text{RS}}$ before X2/CLKIN low <sup>§</sup>                                       | 5       |     | 5       |     | ns   |
| $t_{\text{su}}(\text{BIO})$    | Setup time, $\overline{\text{BIO}}$ before CLKOUT low   | 10      | 2H  | 10      | 2H  | ns   |
| $t_{\text{su}}(\text{INT})$    | Setup time, $\overline{\text{INTn}}$ , $\overline{\text{NMI}}$ , $\overline{\text{RS}}$ before CLKOUT low | 10      | 2H  | 10      | 2H  | ns   |
| $t_{\text{su}}(\text{MPMC})$   | Setup time, $\text{MP}/\overline{\text{MC}}$ before CLKOUT low  | 10      |     | 10      |     | ns   |

<sup>†</sup> The external interrupts ( $\overline{\text{INT0}}-\overline{\text{INT3}}$ ,  $\overline{\text{NMI}}$ ) are synchronized to the core CPU by way of a two flip-flop synchronizer which samples these inputs with consecutive falling edges of CLKOUT. The input to the interrupt pins is required to represent a 1-0-0 sequence at the timing that is corresponding to three CLKOUTs sampling sequence.

<sup>‡</sup> If the PLL mode is selected, then at power-on sequence, or at wakeup from IDLE3,  $\overline{\text{RS}}$  must be held low for at least 50  $\mu\text{s}$  to assure synchronization and lock-in of the PLL.

<sup>§</sup> Divide-by-two mode

<sup>¶</sup> Note that  $\overline{\text{RS}}$  may cause a change in clock frequency, therefore changing the value of H (see the PLL section).

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## reset, $\overline{\text{BIO}}$ , interrupt, and $\text{MP}/\overline{\text{MC}}$ timings (continued)

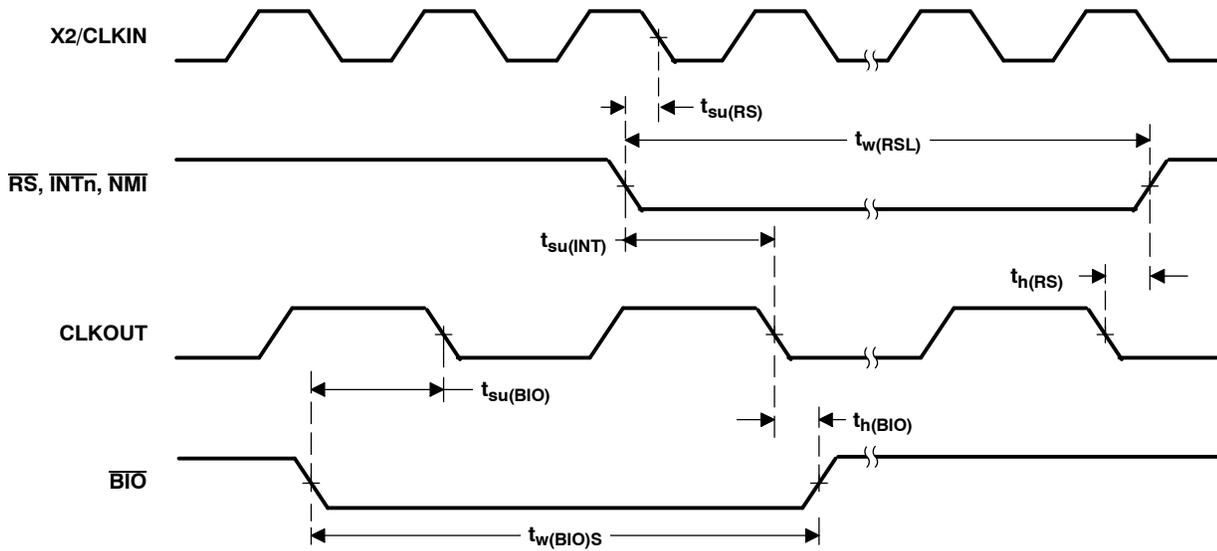


Figure 15. Reset and  $\overline{\text{BIO}}$  Timings

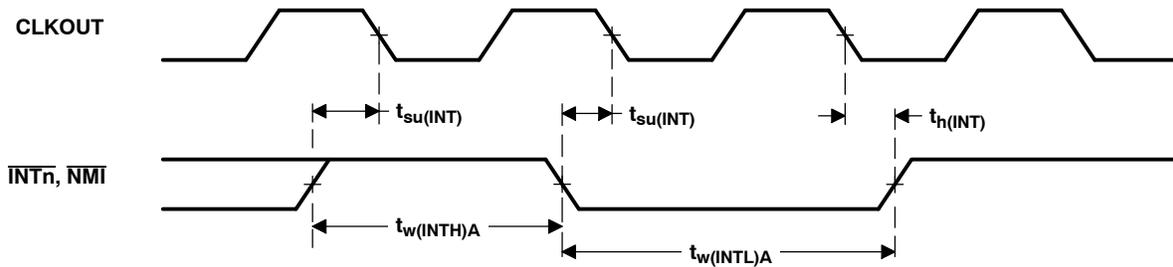


Figure 16. Interrupt Timing

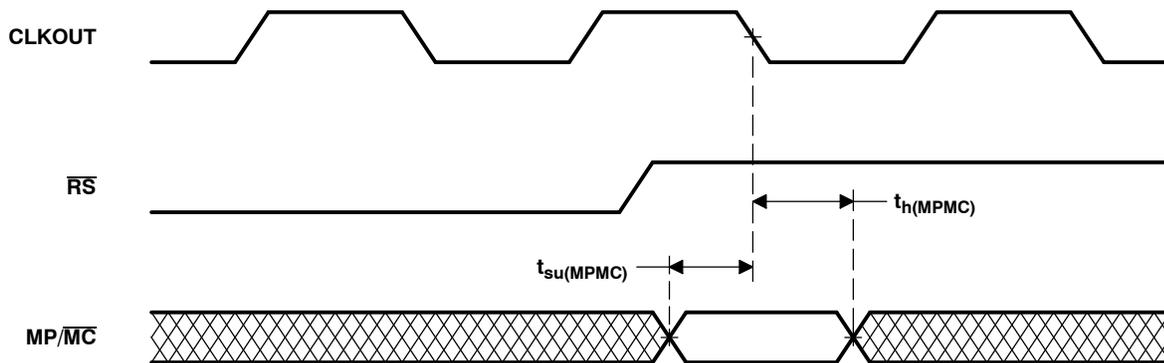


Figure 17.  $\text{MP}/\overline{\text{MC}}$  Timing

instruction acquisition ( $\overline{IAQ}$ ), interrupt acknowledge ( $\overline{IACK}$ ), external flag (XF), and TOUT timings

switching characteristics over recommended operating conditions for  $\overline{IAQ}$  and  $\overline{IACK}$  [H = 0.5  $t_{c(CO)}$ ] (see Figure 18)

| PARAMETER           |  | '548-66 |     | '548-80 |     | UNIT |
|---------------------|--|---------|-----|---------|-----|------|
|                     |  | MIN     | MAX | MIN     | MAX |      |
| $t_{d(CLKL-IAQL)}$  | Delay time, $\overline{IAQ}$ low from CLKOUT low       | 0       | 5   | 0       | 5   | ns   |
| $t_{d(CLKL-IAQH)}$  | Delay time, $\overline{IAQ}$ high from CLKOUT low      | - 2     | 3   | 0       | 5   | ns   |
| $t_{d(A)IAQ}$       | Delay time, address valid before $\overline{IAQ}$ low  |         | 4   |         | 4   | ns   |
| $t_{d(CLKL-IACKL)}$ | Delay time, $\overline{IACK}$ low from CLKOUT low      | - 2     | 3   | - 1     | 4   | ns   |
| $t_{d(CLKL-IACKH)}$ | Delay time, $\overline{IACK}$ high from CLKOUT low     | - 2     | 3   | - 1     | 4   | ns   |
| $t_{d(A)IACK}$      | Delay time, address valid before $\overline{IACK}$ low |         | 3   |         | 3   | ns   |
| $t_{h(A)IAQ}$       | Hold time, address valid after $\overline{IAQ}$ high   | 0       |     | - 4     |     | ns   |
| $t_{h(A)IACK}$      | Hold time, address valid after $\overline{IACK}$ high  | 0       |     | - 3     |     | ns   |
| $t_w(IAQL)$         | Pulse duration, $\overline{IAQ}$ low                   | 2H-3    |     | 2H-3    |     | ns   |
| $t_w(IACKL)$        | Pulse duration, $\overline{IACK}$ low                  | 2H-3    |     | 2H-3    |     | ns   |

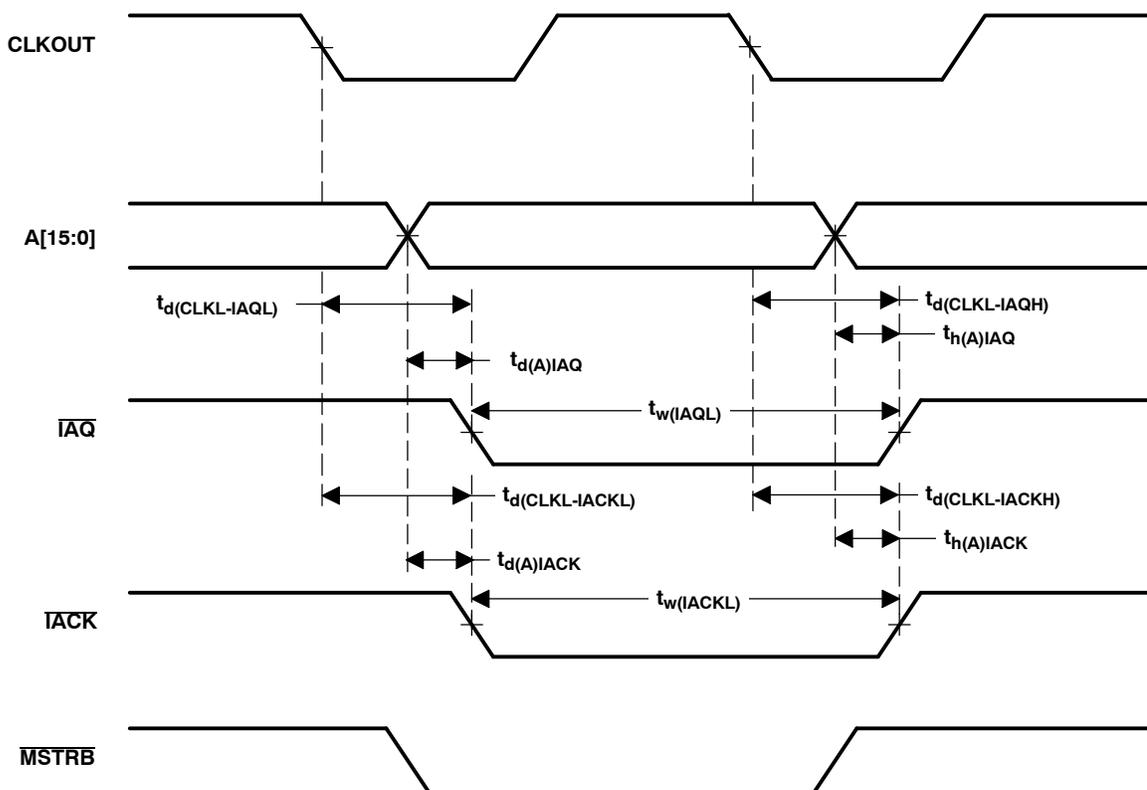


Figure 18. Instruction Acquisition ( $\overline{IAQ}$ ) and Interrupt Acknowledge ( $\overline{IACK}$ ) Timing

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instruction acquisition ( $\overline{IAQ}$ ), interrupt acknowledge ( $\overline{IACK}$ ), external flag (XF), and TOUT timings (continued)

switching characteristics over recommended operating conditions for external flag (XF) and TOUT [ $H = 0.5 t_{c(CO)}$ ] (see Figure 19 and Figure 20)

| PARAMETER      |  | '548-66 |     | '548-80 |     | UNIT |
|----------------|--|---------|-----|---------|-----|------|
|                |  | MIN     | MAX | MIN     | MAX |      |
| $t_{d(XF)}$    | Delay time, XF high after CLKOUT low   | 0       | 5   | 0       | 5   | ns   |
|                | Delay time, XF low after CLKOUT low    | 0       | 5   | 0       | 5   |      |
| $t_{d(TOUTH)}$ | Delay time, TOUT high after CLKOUT low | -2      | 3   | 0       | 4   | ns   |
| $t_{d(TOURL)}$ | Delay time, TOUT low after CLKOUT low  | -2      | 3   | 0       | 4   | ns   |
| $t_w(TOUT)$    | Pulse duration, TOUT                   | 2H-3    |     | 2H-3    |     | ns   |

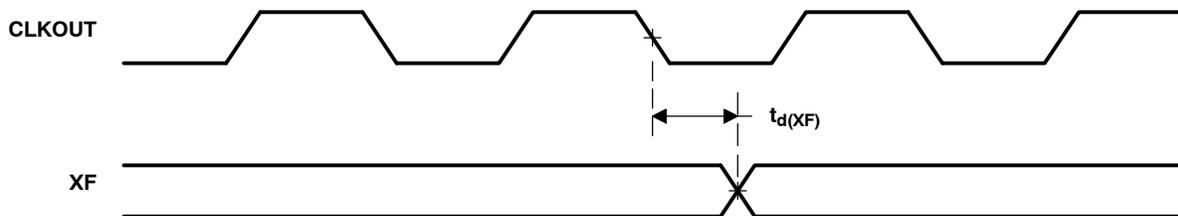


Figure 19. External Flag (XF) Timing

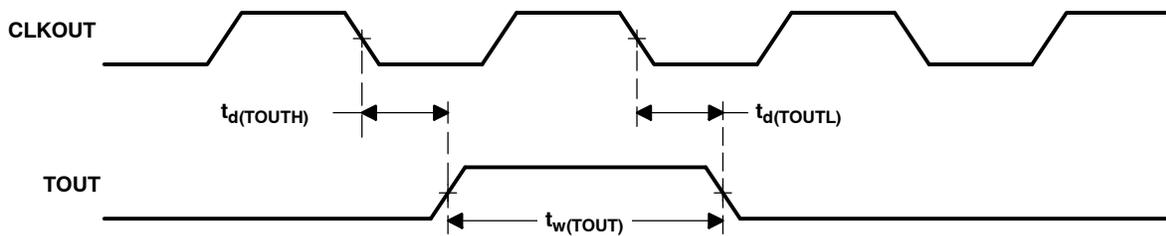


Figure 20. TOUT Timing

serial port receive timing

timing requirements for serial port receive [ $H = 0.5 t_{c(CO)}$ ] (see Figure 21)

|   | '548-66 |     | '548-80 |     | UNIT |
|---|---------|-----|---------|-----|------|
|   | MIN     | MAX | MIN     | MAX |      |
| $t_{c(SCK)}$ Cycle time, serial port clock              | 6H      | †   | 6H      | †   | ns   |
| $t_{f(SCK)}$ Fall time, serial port clock               |         | 6   |         | 6   | ns   |
| $t_{r(SCK)}$ Rise time, serial port clock               |         | 6   |         | 6   | ns   |
| $t_{w(SCK)}$ Pulse duration, serial port clock low/high | 3H      |     | 3H      |     | ns   |
| $t_{su(FSR)}$ Setup time, FSR before CLKR falling edge  | 6       |     | 4       |     | ns   |
| $t_{h(FSR)}$ Hold time, FSR after CLKR falling edge     | 6       |     | 4       |     | ns   |
| $t_{h(DR)}$ Hold time, DR after CLKR falling edge       | 6       |     | 6       |     | ns   |
| $t_{su(DR)}$ Setup time, DR before CLKR falling edge    | 6       |     | 6       |     | ns   |

† The serial port design is fully static and, therefore, can operate with  $t_{c(SCK)}$  approaching  $\infty$ . It is characterized approaching an input frequency of 0 Hz but tested at a much higher frequency to minimize test time.

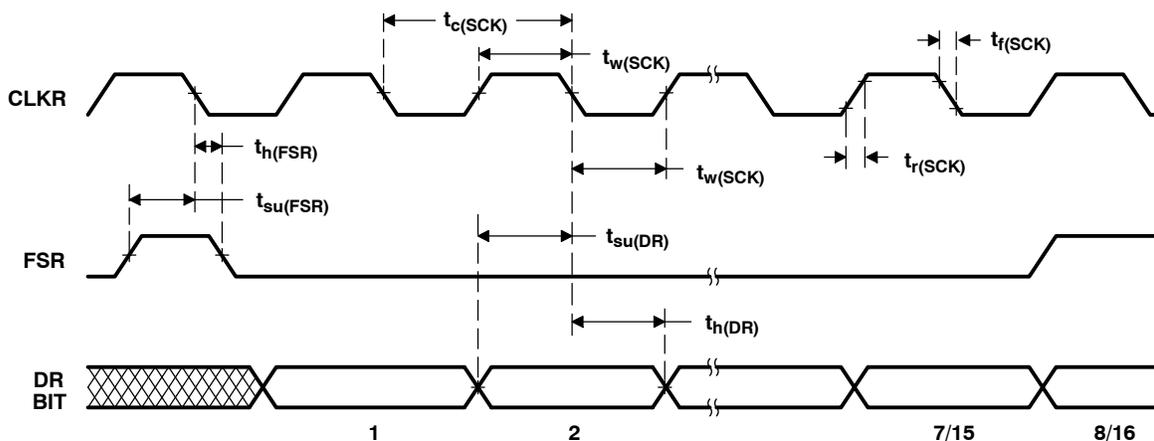


Figure 21. Serial Port Receive Timing

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## serial port transmit timing

switching characteristics over recommended operating conditions for serial port transmit with external clocks and frames (see Figure 22)

| PARAMETER  | '548-66 |     | '548-80 |     | UNIT |
|--|---------|-----|---------|-----|------|
|  | MIN     | MAX | MIN     | MAX |      |
| $t_{d(DX)}$ Delay time, DX valid after CLKX rising |         | 25  |         | 25  | ns   |
| $t_{h(DX)}$ Hold time, DX valid after CLKX rising  | -5      |     | -5      |     | ns   |
| $t_{dis(DX)}$ Disable time, DX after CLKX rising   |         | 40  |         | 40  | ns   |

timing requirements for serial port transmit with external clocks and frames [ $H = 0.5t_{c(CO)}$ ] (see Figure 22)

|  | '548-66 |       | '548-80 |       | UNIT |
|--|---------|-------|---------|-------|------|
|  | MIN     | MAX   | MIN     | MAX   |      |
| $t_{c(SCK)}$ Cycle time, serial port clock                       | 6H      | †     | 6H      | †     | ns   |
| $t_{h(FSX)}$ Hold time, FSX after CLKX falling edge (see Note 1) | 6       |       | 6       |       | ns   |
| $t_{h(FSX)H}$ Hold time, FSX after CLKX rising edge (see Note 1) |         | 2H-5‡ |         | 2H-3‡ | ns   |
| $t_f(SCK)$ Fall time, serial port clock                          |         | 6     |         | 6     | ns   |
| $t_r(SCK)$ Rise time, serial port clock                          |         | 6     |         | 6     | ns   |
| $t_w(SCK)$ Pulse duration, serial port clock low/high            | 3H      |       | 3H      |       | ns   |
| $t_d(FSX)$ Delay time, FSX after CLKX rising edge                |         | 2H-5  |         | 2H-3  | ns   |

† The serial port design is fully static and, therefore, can operate with  $t_{c(SCK)}$  approaching  $\infty$ . It is characterized approaching an input frequency of 0 Hz but tested at a much higher frequency to minimize test time.

‡ If the FSX pulse does not meet this specification, the first bit of serial data is driven on DX until the falling edge of FSX. After the falling edge of FSX, data is shifted out on DX pin. The transmit buffer-empty interrupt is generated when the  $t_{h(FSX)}$  and  $t_{h(FSX)H}$  specification is met.

NOTE 1: Internal clock with external FSX and vice versa are also allowable. However, FSX timings to CLKX always are defined depending on the source of FSX, and CLKX timings always are dependent upon the source of CLKX. Specifically, the relationship of FSX to CLKX is independent of the source of CLKX.

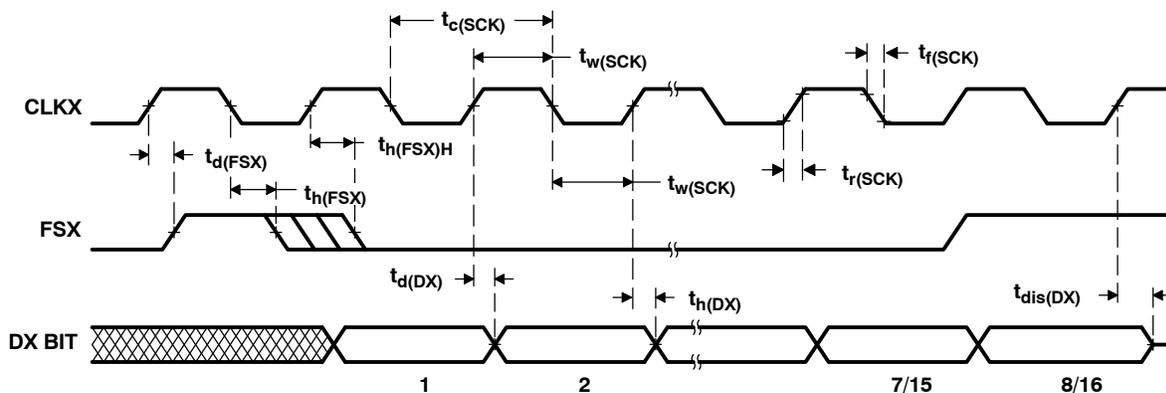


Figure 22. Serial Port Transmit Timing With External Clocks and Frames

serial port transmit timing (continued)

switching characteristics over recommended operating conditions for serial port transmit with internal clocks and frames [H = 0.5t<sub>c(CO)</sub>] (see Figure 23)

| PARAMETER  | '548-66 |     |     | '548-80 |     |     | UNIT |
|--|---------|-----|-----|---------|-----|-----|------|
|  | MIN     | TYP | MAX | MIN     | TYP | MAX |      |
| t <sub>c(SCK)</sub> Cycle time, serial port clock              | 8H      |     |     | 8H      |     |     | ns   |
| t <sub>d(FSX)</sub> Delay time, CLKX rising to FSX             | 15      |     |     | 7       |     |     | ns   |
| t <sub>d(DX)</sub> Delay time, CLKX rising to DX               | 15      |     |     | 7       |     |     | ns   |
| t <sub>dis(DX)</sub> Disable time, CLKX rising to DX           | 20      |     |     | 20      |     |     | ns   |
| t <sub>h(DX)</sub> Hold time, DX valid after CLKX rising edge  | - 5     |     |     | - 2     |     |     | ns   |
| t <sub>f(SCK)</sub> Fall time, serial port clock               | 4       |     |     | 3       |     |     | ns   |
| t <sub>r(SCK)</sub> Rise time, serial port clock               | 4       |     |     | 3       |     |     | ns   |
| t <sub>w(SCK)</sub> Pulse duration, serial port clock low/high | 4H-8    |     |     | 4H-4    |     |     | ns   |

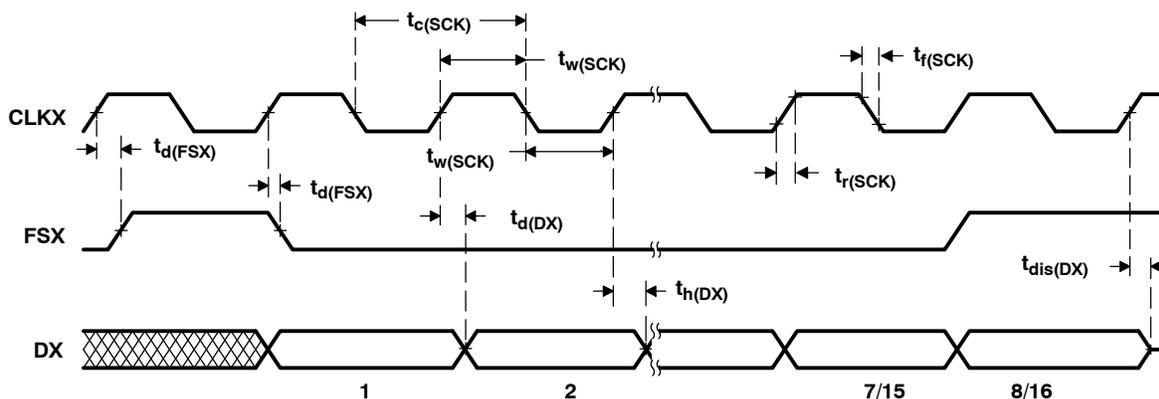


Figure 23. Serial Port Transmit Timing With Internal Clocks and Frames

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## buffered serial port receive timing

### timing requirements (see Figure 24)

|  | '548-66 |                             | '548-80 |                             | UNIT |
|--|---------|-----------------------------|---------|-----------------------------|------|
|  | MIN     | MAX                         | MIN     | MAX                         |      |
| $t_{c(SCK)}$ Cycle time, serial port clock                             | 20      | †                           | 20      | †                           | ns   |
| $t_{f(SCK)}$ Fall time, serial port clock                              |         | 4                           |         | 4                           | ns   |
| $t_{r(SCK)}$ Rise time, serial port clock                              |         | 4                           |         | 4                           | ns   |
| $t_{w(SCK)}$ Pulse duration, serial port clock low/high                | 6       |                             | 6       |                             | ns   |
| $t_{su(BFSR)}$ Setup time, BFSR before BCLKR falling edge (see Note 2) | 2       |                             | 2       |                             | ns   |
| $t_{h(BFSR)}$ Hold time, BFSR after BCLKR falling edge (see Note 2)    | 10      | $t_{c(SCK)} - 2^{\ddagger}$ | 10      | $t_{c(SCK)} - 2^{\ddagger}$ | ns   |
| $t_{su(BDR)}$ Setup time, BDR before BCLKR falling edge                | 0       |                             | 0       |                             | ns   |
| $t_{h(BDR)}$ Hold time, BDR after BCLKR falling edge                   | 10      |                             | 10      |                             | ns   |

† The serial port design is fully static and therefore can operate with  $t_{c(SCK)}$  approaching infinity. It is characterized approaching an input frequency of 0 Hz but tested at a much higher frequency to minimize test time.

‡ First bit is read when BFSR is sampled low by BCLKR clock.

NOTE 2: Timings for BCLKR and BFSR are given with polarity bits (BCLKP and BFSP) set to 0.

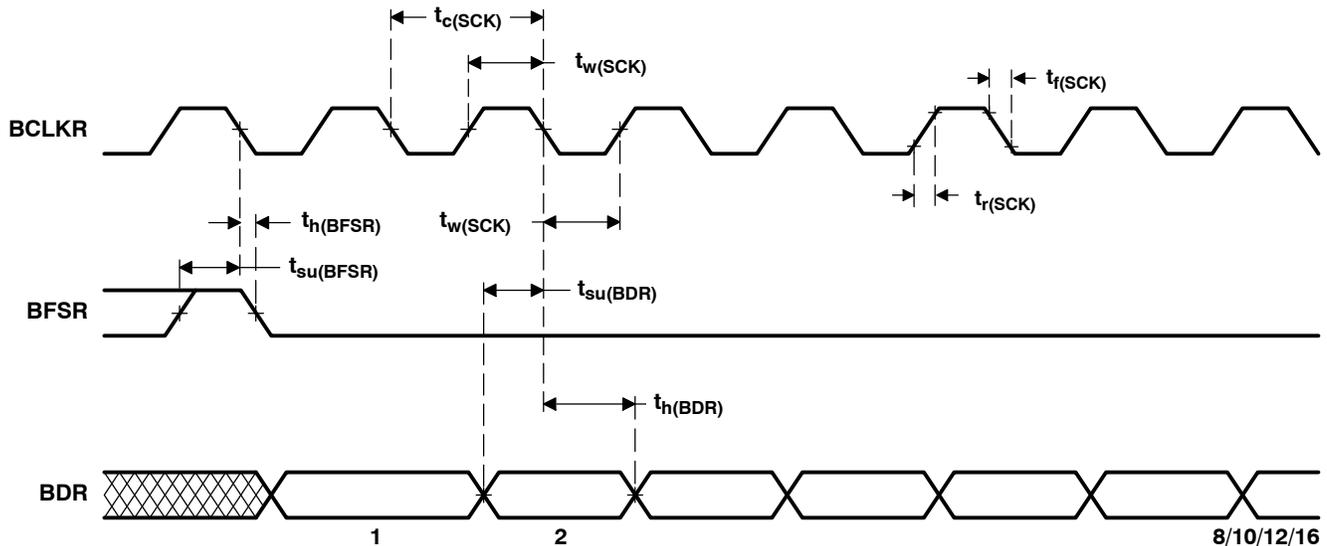


Figure 24. Buffered Serial Port Receive Timing

**buffered serial port transmit timing of external frames**

**switching characteristics over recommended operating conditions (see Figure 25)**

| PARAMETER            |  | '548-66 |     | '548-80 |     | UNIT |
|----------------------|--|---------|-----|---------|-----|------|
|                      |  | MIN     | MAX | MIN     | MAX |      |
| $t_{d(BDX)}$         | Delay time, BDX valid after BCLKX rising       |         | 18  |         | 18  | ns   |
| $t_{dis(BDX)}$       | Disable time, BDX after BCLKX rising           | 4       | 6   | 4       | 6   | ns   |
| $t_{dis(BDX)_{pcm}}$ | Disable time, PCM mode, BDX after BCLKX rising |         | 6   |         | 6   | ns   |
| $t_{en(BDX)_{pcm}}$  | Enable time, PCM mode, BDX after BCLKX rising  |         | 8   |         | 8   | ns   |
| $t_h(BDX)$           | Hold time, BDX valid after BCLKX rising        |         | 2   |         | 2   | ns   |

**timing requirements (see Figure 25)**

|                |  | '548-66 |                           | '548-80 |                           | UNIT |
|----------------|--|---------|---------------------------|---------|---------------------------|------|
|                |  | MIN     | MAX                       | MIN     | MAX                       |      |
| $t_{c(SCK)}$   | Cycle time, serial port clock                                | 20      | †                         | 20      | †                         | ns   |
| $t_f(SCK)$     | Fall time, serial port clock                                 |         | 4                         |         | 4                         | ns   |
| $t_r(SCK)$     | Rise time, serial port clock                                 |         | 4                         |         | 4                         | ns   |
| $t_w(SCK)$     | Pulse duration, serial port clock low/high                   | 6       |                           | 6       |                           | ns   |
| $t_h(BFSX)$    | Hold time, BFSX after CLKX falling edge (see Notes 3 and 4)  | 6       | $t_{c(SCK)} - 6^\ddagger$ | 6       | $t_{c(SCK)} - 6^\ddagger$ | ns   |
| $t_{su}(BFSX)$ | Setup time, FSX before CLKX falling edge (see Notes 3 and 4) | 6       |                           | 6       |                           | ns   |

† The serial port design is fully static and therefore can operate with  $t_{c(SCK)}$  approaching infinity. It is characterized approaching an input frequency of 0 Hz but tested at a much higher frequency to minimize test time.

‡ If BFSX does not meet this specification, the first bit of the serial data is driven on BDX until BFSX goes low (sampled on falling edge of BCLKX). After falling edge of the BFSX, data will be shifted out on the BDX pin.

NOTES: 3. Internal clock with external BFSX and vice versa are also allowable. However, BFSX timings to BCLKX always are defined depending on the source of BFSX, and BCLKX timings always are dependent upon the source of BCLKX.

4. Timings for BCLKX and BFSX are given with polarity bits (BCLKP and BFSP) set to 0.

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## buffered serial port transmit timing of external frames (continued)

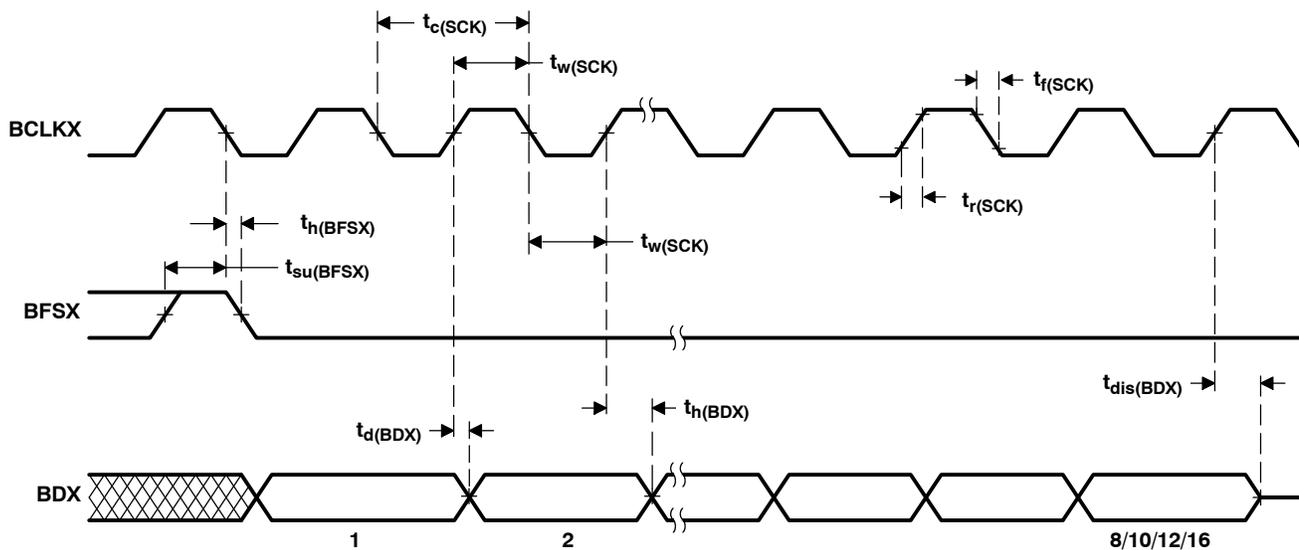


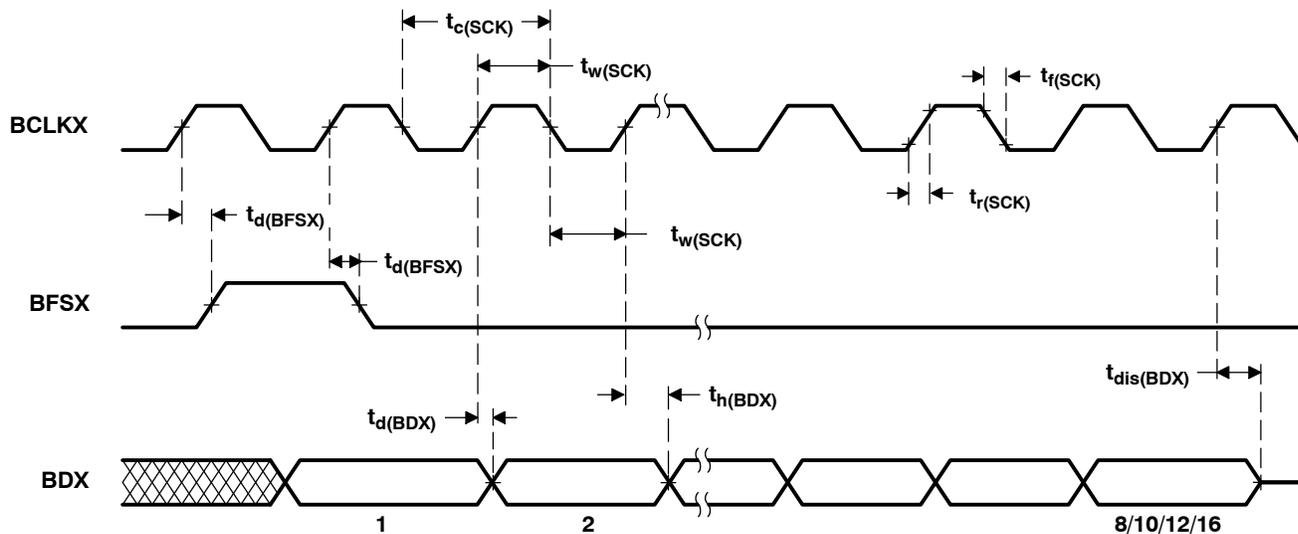
Figure 25. Buffered Serial Port Transmit Timing of External Clocks and External Frames

**buffered serial port transmit timing of internal frame and internal clock**

**switching characteristics over recommended operating conditions [ $H = 0.5t_{c(CO)}$ ] (see Figure 26)**

| PARAMETER         | '548-66 |     | '548-80 |     | UNIT |
|-------------------|---------|-----|---------|-----|------|
|                   | MIN     | MAX | MIN     | MAX |      |
| $t_{c(SCK)}$      | 20      | 62H | 20      | 62H | ns   |
| $t_{d(BFSX)}$     | 0       | 10  | 0       | 10  | ns   |
| $t_{d(BDX)}$      |         | 8   |         | 8   | ns   |
| $t_{dis(BDX)}$    | 0       | 5   | 0       | 5   | ns   |
| $t_{dis(BDX)pcm}$ |         | 5   |         | 5   | ns   |
| $t_{en(BDX)pcm}$  | 7       |     | 7       |     | ns   |
| $t_h(BDX)$        | 0       |     | 0       |     | ns   |
| $t_f(SCK)$        |         | 4   |         | 4   | ns   |
| $t_r(SCK)$        |         | 4   |         | 4   | ns   |
| $t_w(SCK)$        | 6       |     | 6       |     | ns   |

- NOTES: 3. Internal clock with external BFSX and vice versa are also allowable. However, BFSX timings to BCLKX always are defined depending on the source of BFSX, and BCLKX timings always are dependent upon the source of BCLKX.  
4. Timings for BCLKX and BFSX are given with polarity bits (BCLKP and BFSP) set to 0.



**Figure 26. Buffered Serial Port Transmit Timing of Internal Clocks and Internal Frames**

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## serial-port receive timing in TDM mode

### timing requirements [ $H = 0.5t_{c(CO)}$ ] (see Figure 27)

|  | '548-66 |     | '548-80 |     | UNIT |
|--|---------|-----|---------|-----|------|
|  | MIN     | MAX | MIN     | MAX |      |
| $t_{c(SCK)}$ Cycle time, serial-port clock                     | 16H     | †   | 16H     | †   | ns   |
| $t_f(SCK)$ Fall time, serial-port clock                        |         | 6   |         | 6   | ns   |
| $t_r(SCK)$ Rise time, serial-port clock                        |         | 6   |         | 6   | ns   |
| $t_w(SCK)$ Pulse duration, serial-port clock low/high          | 8H      |     | 8H      |     | ns   |
| $t_{su(TD-TCH)}$ Setup time, TDAT/TADD before TCLK rising edge | 10      |     | 10      |     | ns   |
| $t_h(TCH-TD)$ Hold time, TDAT/TADD after TCLK rising edge      | 1       |     | 1       |     | ns   |
| $t_{su(TF-TCH)}$ Setup time, TFRM before TCLK rising edge‡     | 10      |     | 10      |     | ns   |
| $t_h(TCH-TF)$ Hold time, TFRM after TCLK rising edge‡          | 10      |     | 10      |     | ns   |

† The serial-port design is fully static and, therefore, can operate with  $t_{c(SCK)}$  approaching infinity. It is characterized approaching an input frequency of 0 Hz but tested at a much higher frequency to minimize test time.

‡ TFRM timing and waveforms shown in Figure 27 are for external TFRM. TFRM can also be configured as internal. The TFRM internal case is illustrated in the transmit timing diagram in Figure 28.



serial-port receive timing in TDM mode (continued)

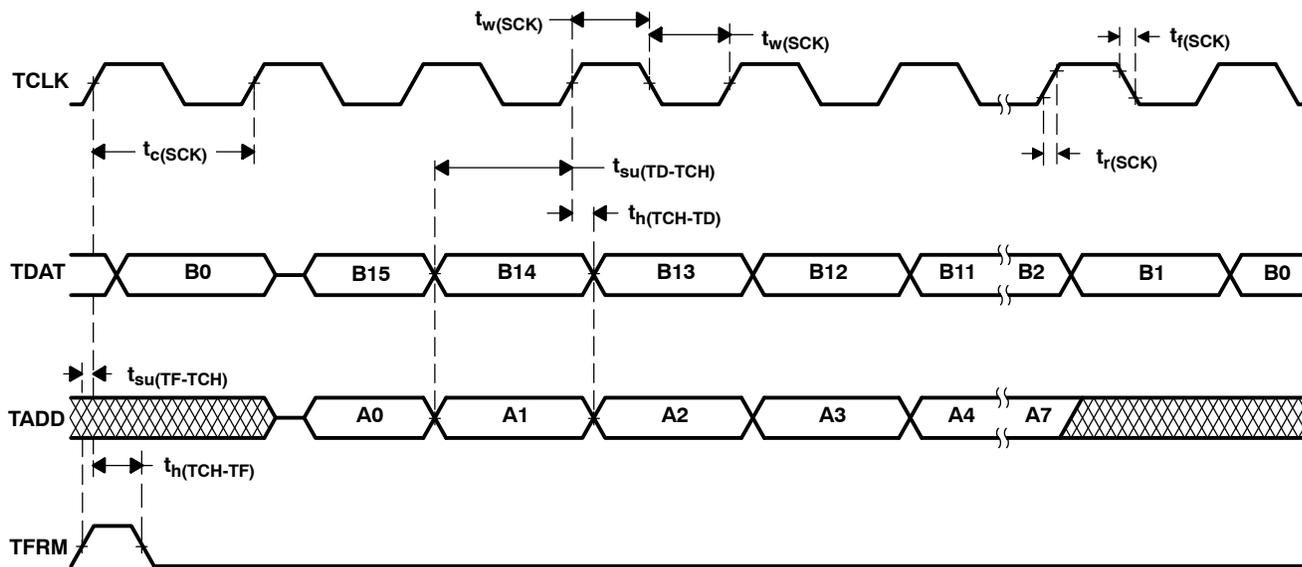


Figure 27. Serial-Port Receive Timing in TDM Mode

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## serial-port transmit timing in TDM mode

### switching characteristics over recommended operating conditions [ $H = 0.5t_{c(CO)}$ ] (see Figure 28)

| PARAMETER      |  | '548-66 |         | '548-80 |       | UNIT |
|----------------|--|---------|---------|---------|-------|------|
|                |  | MIN     | MAX     | MIN     | MAX   |      |
| $t_h(TCH-TDV)$ | Hold time, TDAT/TADD valid after TCLK rising edge, TCLK external     | 1       |         | 1       |       | ns   |
| $t_h(TCH-TDV)$ | Hold time, TDAT/TADD valid after TCLK rising edge, TCLK internal     | 1       |         | 1       |       | ns   |
| $t_d(TCH-TFV)$ | Delay time, TFRM valid after TCLK rising edge TCLK ext <sup>†</sup>  | H - 3   | 3H + 22 | H - 3   | 3H+22 | ns   |
|                | Delay time, TFRM valid after TCLK rising edge, TCLK int <sup>†</sup> | H - 3   | 3H + 12 | H - 3   | 3H+12 |      |
| $t_d(TC-TDV)$  | Delay time, TCLK to valid TDAT/TADD, TCLK ext                        |         | 25      |         | 25    | ns   |
|                | Delay time, TCLK to valid TDAT/TADD, TCLK int                        |         | 18      |         | 18    |      |

<sup>†</sup> TFRM timing and waveforms shown in Figure 28 are for internal TFRM. TFRM can also be configured as external. The TFRM external case is illustrated in the receive timing diagram in Figure 27.



serial-port transmit timing in TDM mode (continued)

timing requirements [ $H = 0.5t_{c(CO)}$ ] (see Figure 28)

|   | '548-66          |     | '548-80          |     | UNIT |
|---|------------------|-----|------------------|-----|------|
|   | MIN              | MAX | MIN              | MAX |      |
| $t_{c(SCK)}$ Cycle time, serial-port clock            | 16H <sup>†</sup> | ‡   | 16H <sup>†</sup> | ‡   | ns   |
| $t_f(SCK)$ Fall time, serial-port clock               |                  | 6   |                  | 6   | ns   |
| $t_r(SCK)$ Rise time, serial-port clock               |                  | 6   |                  | 6   | ns   |
| $t_w(SCK)$ Pulse duration, serial-port clock low/high | 8H <sup>†</sup>  |     | 8H <sup>†</sup>  |     | ns   |

<sup>†</sup> When SCK is generated internally, this value is typical.

<sup>‡</sup> The serial-port design is fully static and, therefore, can operate with  $t_{c(SCK)}$  approaching  $\infty$ . It is characterized approaching an input frequency of 0 Hz but tested as a much higher frequency to minimize test time.

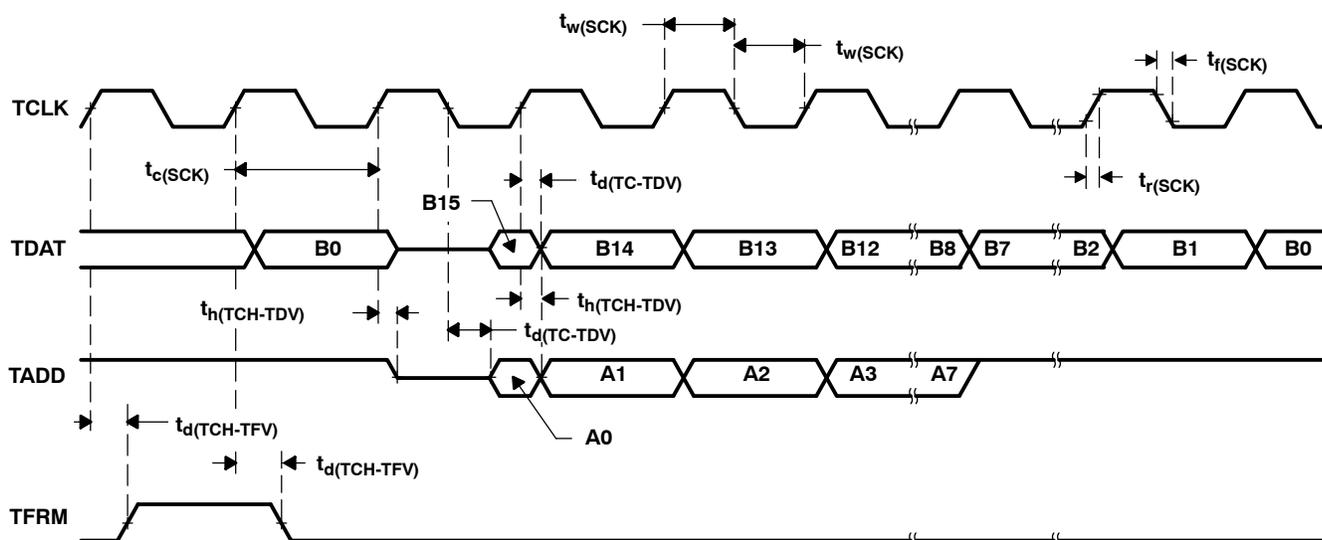


Figure 28. Serial-Port Transmit Timing in TDM Mode

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## host port interface timing

switching characteristics over recommended operating conditions [H = 0.5t<sub>c(CO)</sub>]  
(see Notes 5 and 6) (see Figure 29 through Figure 32)

| PARAMETER                |  | '548-66  |                           | UNIT |
|--------------------------|--|--|---------------------------|------|
|                          |  | MIN  | MAX                       |      |
| t <sub>d(DSL-HDV)</sub>  | Delay time, $\overline{DS}$ low to HD driven   | 5  | 12                        | ns   |
| t <sub>d(HEL-HDV1)</sub> | Delay time, HDS falling to HD valid for first byte of a non-subsequent read: → max 20 ns <sup>†‡</sup> | Case 1: Shared-access mode if t <sub>w(DSH)</sub> < 7H | 7H+20-t <sub>w(DSH)</sub> | ns   |
|                          |  | Case 2: Shared-access mode if t <sub>w(DSH)</sub> > 7H | 20                        |      |
|                          |  | Case 3: Host-only mode if t <sub>w(DSH)</sub> < 20 ns  | 40-t <sub>w(DSH)</sub>    |      |
|                          |  | Case 4: Host-only mode if t <sub>w(DSH)</sub> > 20 ns  | 20                        |      |
| t <sub>d(DSL-HDV2)</sub> | Delay time, $\overline{DS}$ low to HD valid, second byte   | 5 <sup>‡</sup>   | 20                        | ns   |
| t <sub>d(DSH-HYH)</sub>  | Delay time, $\overline{DS}$ high to HRDY high  |  | 10H+10                    | ns   |
| t <sub>su(HDV-HYH)</sub> | Setup time, HD valid before HRDY rising edge   | 3H-10  |                           | ns   |
| t <sub>h(DSH-HDV)R</sub> | Hold time, HD valid after $\overline{DS}$ rising edge, read  | 0  | 12                        | ns   |
| t <sub>d(COH-HYH)</sub>  | Delay time, CLKOUT rising edge to HRDY high  |  | 10                        | ns   |
| t <sub>d(DSH-HYL)</sub>  | Delay time, $\overline{HDS}$ or $\overline{HCS}$ high to HRDY low                                      |  | 12                        | ns   |
| t <sub>d(COH-HTX)</sub>  | Delay time, CLKOUT rising edge to $\overline{HINT}$ change   |  | 15                        | ns   |

<sup>†</sup> Host-only mode timings apply for read accesses to HPIC or HPIA, write accesses to BOB, and resetting DSPINT or HINT to 0 in shared-access mode. HRDY does not go low for these accesses.

<sup>‡</sup> Shared-access mode timings will be met automatically if HRDY is used.

NOTES: 5. SAM = shared-access mode, HOM = host-only mode

HAD stands for HCNTRL0, HCNTRL1, and HR/W.

$\overline{HDS}$  refers to either  $\overline{HDS1}$  or  $\overline{HDS2}$ .

$\overline{DS}$  refers to the logical OR of  $\overline{HCS}$  and  $\overline{HDS}$ .

6. On host read accesses to the HPI, the setup time of HD before  $\overline{DS}$  rising edge depends on the host waveforms and cannot be specified here.



**host port interface timing (continued)**

**switching characteristics over recommended operating conditions [H = 0.5t<sub>c(CO)</sub>]  
(see Notes 5 and 6) (see Figure 29 through Figure 32) (continued)**

| PARAMETER                |  | '548-80  |                           | UNIT |
|--------------------------|--|--|---------------------------|------|
|                          |  | MIN  | MAX                       |      |
| t <sub>d(DSL-HDV)</sub>  | Delay time, $\overline{DS}$ low to HD driven   | 5  | 12                        | ns   |
| t <sub>d(HEL-HDV1)</sub> | Delay time, HDS falling to HD valid for first byte of a non-subsequent read: → max 20 ns <sup>†‡</sup> | Case 1: Shared-access mode if t <sub>w(DSH)</sub> < 7H | 7H+20-t <sub>w(DSH)</sub> | ns   |
|                          |  | Case 2: Shared-access mode if t <sub>w(DSH)</sub> > 7H | 20                        |      |
|                          |  | Case 3: Host-only mode if t <sub>w(DSH)</sub> < 20 ns  | 40-t <sub>w(DSH)</sub>    |      |
|                          |  | Case 4: Host-only mode if t <sub>w(DSH)</sub> > 20 ns  | 20                        |      |
| t <sub>d(DSL-HDV2)</sub> | Delay time, $\overline{DS}$ low to HD valid, second byte   | 5 <sup>‡</sup>   | 20                        | ns   |
| t <sub>d(DSH-HYH)</sub>  | Delay time, $\overline{DS}$ high to HRDY high  |  | 10H+10                    | ns   |
| t <sub>su(HDV-HYH)</sub> | Setup time, HD valid before HRDY rising edge   | 3H-10  |                           | ns   |
| t <sub>h(DSH-HDV)R</sub> | Hold time, HD valid after $\overline{DS}$ rising edge, read  | 0  | 12                        | ns   |
| t <sub>d(COH-HYH)</sub>  | Delay time, CLKOUT rising edge to HRDY high  |  | 10                        | ns   |
| t <sub>d(DSH-HYL)</sub>  | Delay time, $\overline{HDS}$ or $\overline{HCS}$ high to HRDY low                                      |  | 12                        | ns   |
| t <sub>d(COH-HTX)</sub>  | Delay time, CLKOUT rising edge to $\overline{HINT}$ change   |  | 15                        | ns   |

<sup>†</sup> Host-only mode timings apply for read accesses to HPIC or HPIA, write accesses to BOB, and resetting DSPINT or HINT to 0 in shared-access mode. HRDY does not go low for these accesses.

<sup>‡</sup> Shared-access mode timings will be met automatically if HRDY is used.

- NOTES: 5. SAM = shared-access mode, HOM = host-only mode  
HAD stands for HCNTL0, HCNTL1, and HR/W.  
 $\overline{HDS}$  refers to either  $\overline{HDS1}$  or  $\overline{HDS2}$ .  
 $\overline{DS}$  refers to the logical OR of  $\overline{HCS}$  and  $\overline{HDS}$ .
6. On host read accesses to the HPI, the setup time of HD before  $\overline{DS}$  rising edge depends on the host waveforms and cannot be specified here.

# TMS320LC548 FIXED-POINT DIGITAL SIGNAL PROCESSOR

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## host port interface timing (continued)

### timing requirements [ $H = 0.5t_{c(CO)}$ ] (see Note 5, Figure 29 through Figure 32)

|                             |  | '548-66   |     | '548-80         |     | UNIT |
|-----------------------------|--|---|-----|-----------------|-----|------|
|                             |  | MIN   | MAX | MIN             | MAX |      |
| $t_{su}(HBV-DSL)$           | Setup time, HAD/HBIL valid before $\overline{DS}$ or $\overline{HAS}$ falling edge | 10  |     | 10              |     | ns   |
| $t_h(DSL-HBV)$              | Hold time, HAD/HBIL valid after $\overline{DS}$ or $\overline{HAS}$ falling edge   | 5   |     | 5               |     | ns   |
| $t_{su}(HSL-DSL)$           | Setup time, $\overline{HAS}$ low before $\overline{DS}$ falling edge               | 12  |     | 12              |     | ns   |
| $t_w(DSL)$                  | Pulse duration, $\overline{DS}$ low  | 30 <sup>†</sup>   |     | 30 <sup>†</sup> |     | ns   |
| $t_w(DSH)$                  | Pulse duration, $\overline{DS}$ high   | 10  |     | 10              |     | ns   |
| $t_{c(DSH-DSH)}^{\ddagger}$ | Cycle time, $\overline{DS}$ rising edge to next $\overline{DS}$ rising edge        | Case 1: HOM access timings (see Access Timing Without HRDY)                                   |     | 50              | 50  | ns   |
|                             |  | Case 2a: SAM accesses and HOM active writes to DSPINT or HINT. (see Access Timings With HRDY) |     | 10H             | 10H |      |
| $t_{su}(HDV-DSH)$           | Setup time, HD valid before $\overline{DS}$ rising edge                            | 12  |     | 12              |     | ns   |
| $t_d(DSH-HSL)^{\ddagger}$   | Delay time, $\overline{DS}$ high to next $\overline{HAS}$ low                      | 10H   |     | 10H             |     | ns   |
| $t_h(DSH - HDV)W$           | Hold time, HD valid after $\overline{DS}$ rising edge, write                       | 3   |     | 3               |     | ns   |

<sup>†</sup> A host not using HRDY should meet the 10H requirement all the time unless a software handshake is used to change the access rate according to the HPI mode.

<sup>‡</sup> Must only be met if  $\overline{HAS}$  is going low when not accessing the HPI (as would be the case where multiple devices are being driven by one host).

NOTE 5: SAM = shared-access mode, HOM = host-only mode

HAD stands for HCNTRL0, HCNTRL1, and HR/W.

HDS refers to either HDS1 or HDS2.

$\overline{DS}$  refers to the logical OR of  $\overline{HCS}$  and  $\overline{HDS}$ .



host port interface timing (continued)

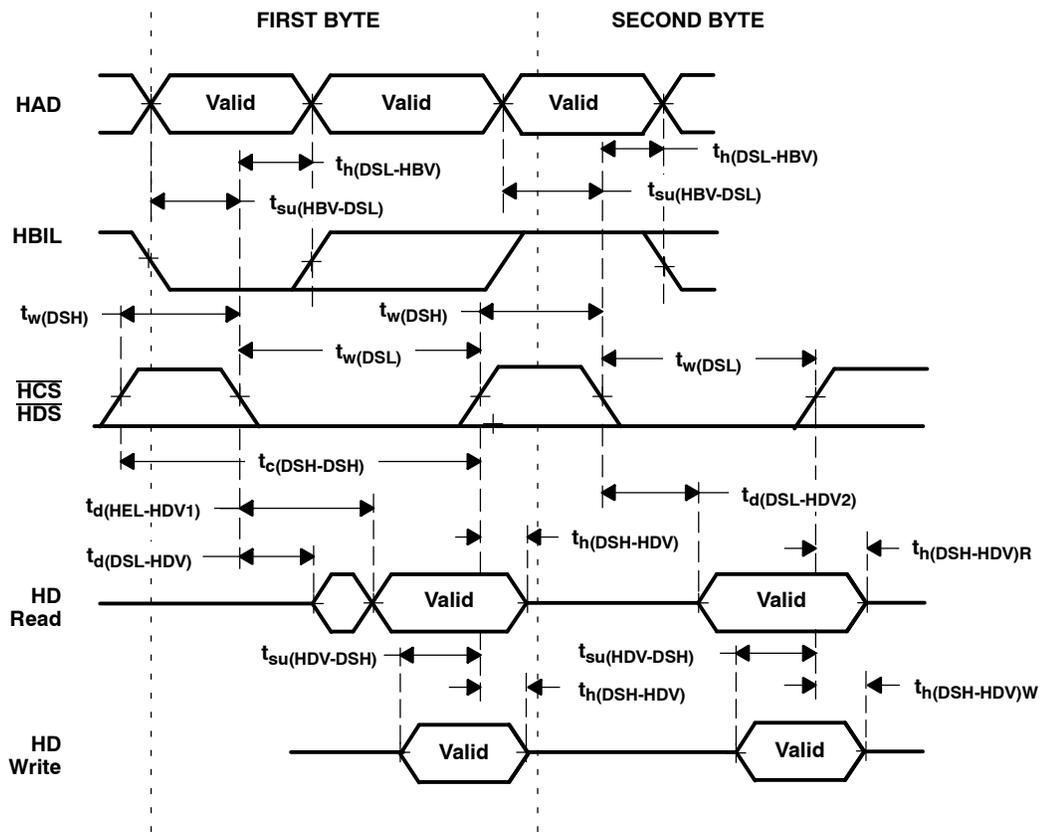


Figure 29. Read/Write Access Timings Without HRDY or HAS

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## host port interface timing (continued)

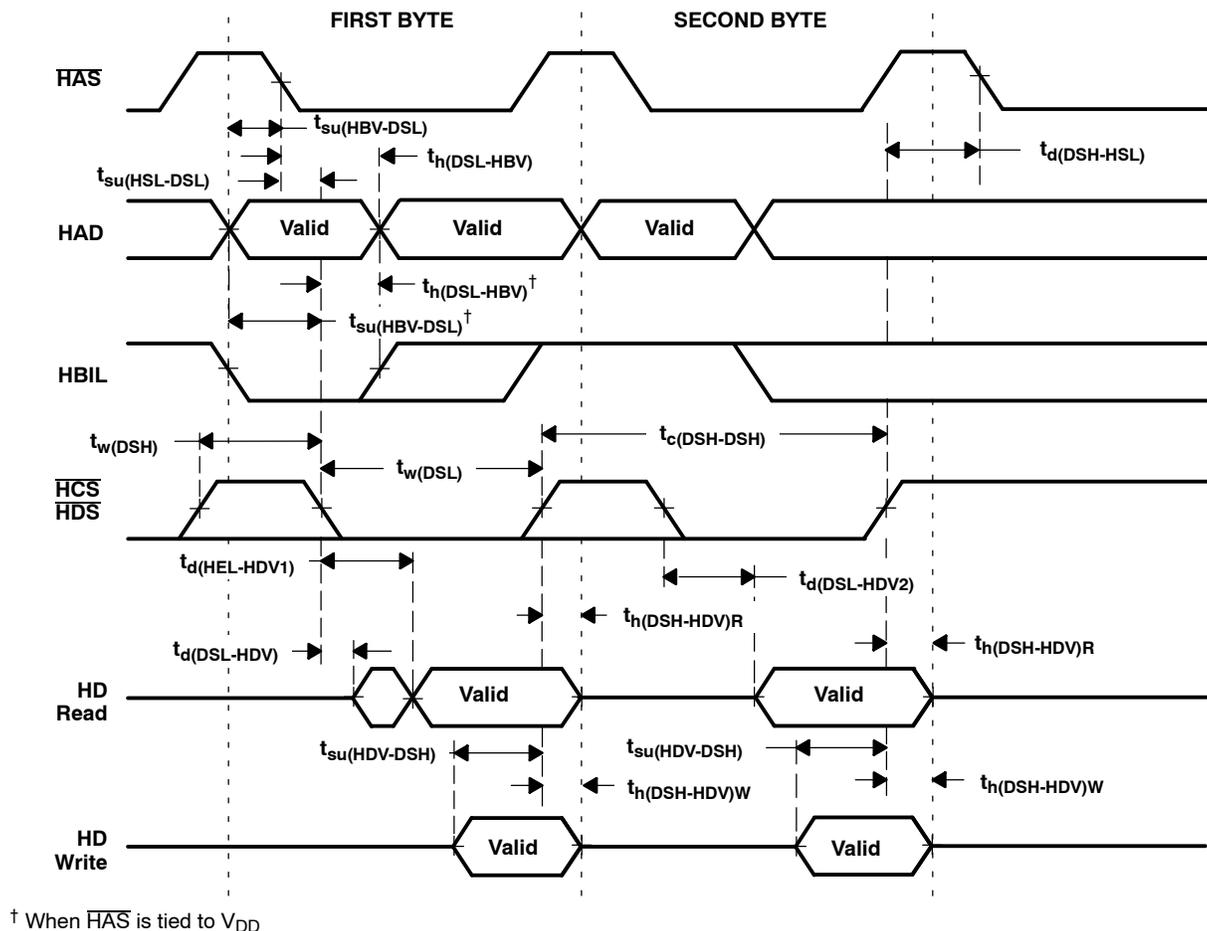


Figure 30. Read/Write Access Timings Using  $\overline{\text{HAS}}$  Without  $\text{HRDY}$

host port interface timing (continued)

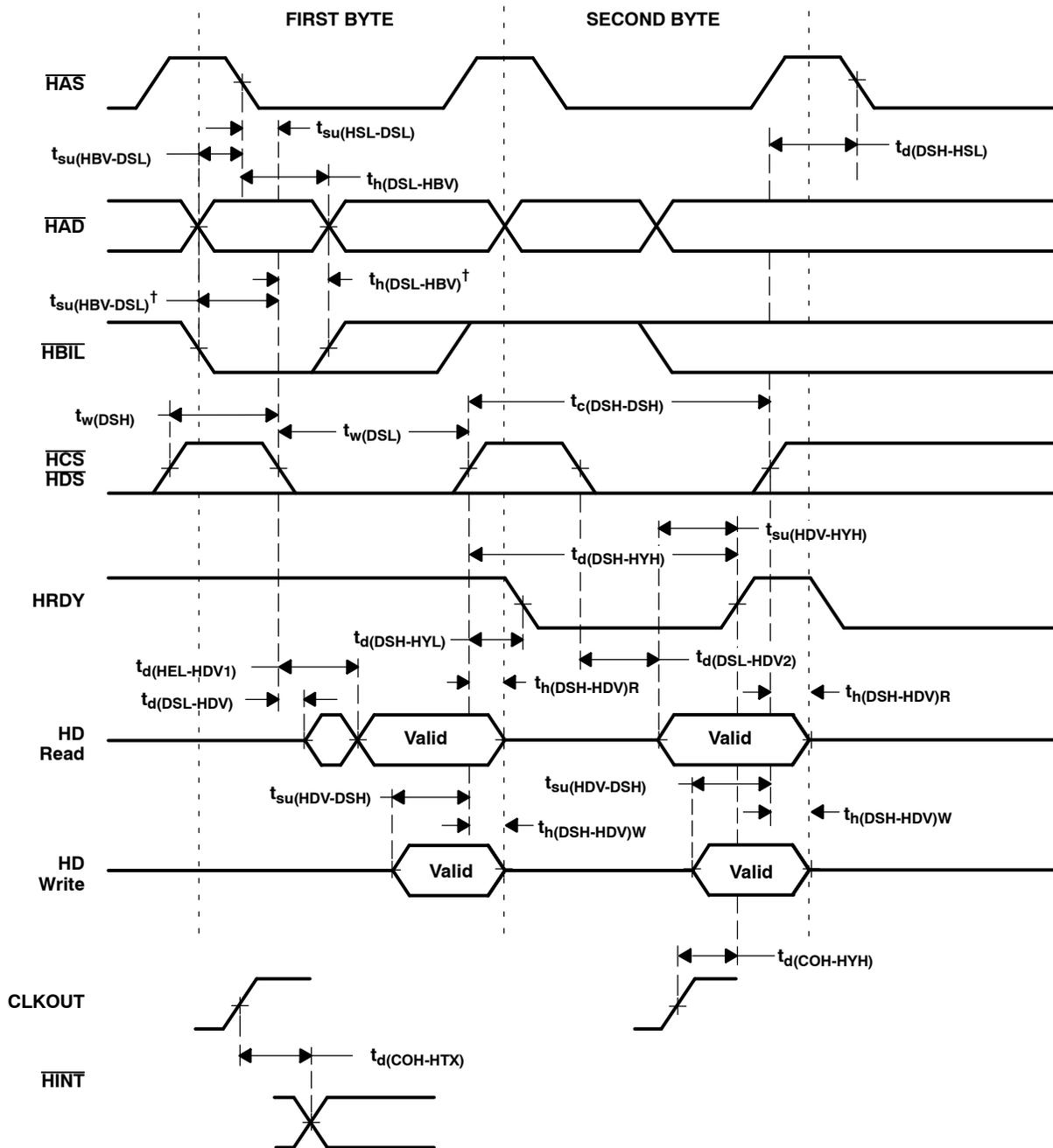


Figure 31. Read/Write Access Timing With HRDY

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## host port interface timing (continued)

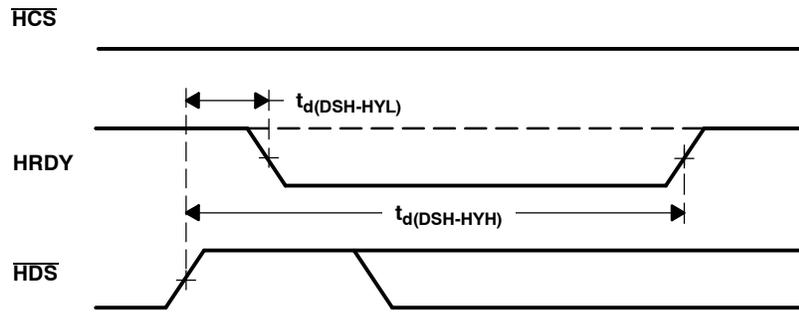


Figure 32. HRDY Signal When  $\overline{HCS}$  is Always Low

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**MECHANICAL DATA**

**Thermal Resistance Characteristics of PGE-144 Package**

| PARAMETER       | °C/W |
|-----------------|------|
| $R_{\theta JA}$ | 56   |
| $R_{\theta JC}$ | 5    |

**Thermal Resistance Characteristics of GGU-144 Package**

| PARAMETER       | °C/W |
|-----------------|------|
| $R_{\theta JA}$ | 38   |
| $R_{\theta JC}$ | 5    |

The following packaging information reflects the most current released data available for the designated device(s). This data is subject to change without notice and without revision of this document.

**PACKAGING INFORMATION**

| Orderable Device  | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples   |
|-------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---|
| TMS320LC548PGE-66 | ACTIVE        | LQFP         | PGE             | 144  | 60          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   |              | -66<br>TMS320LC548PGE   |  |
| TMS320LC548PGE-80 | ACTIVE        | LQFP         | PGE             | 144  | 60          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   |              | -80<br>TMS320LC548PGE   |  |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

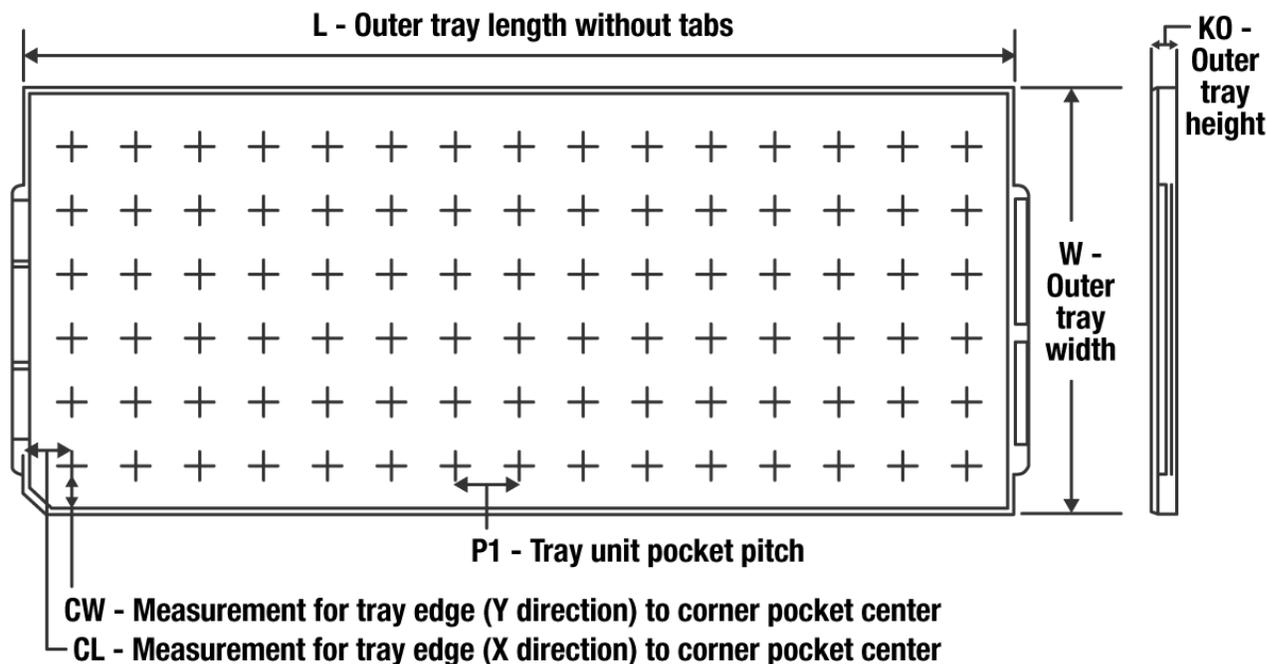
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**TRAY**


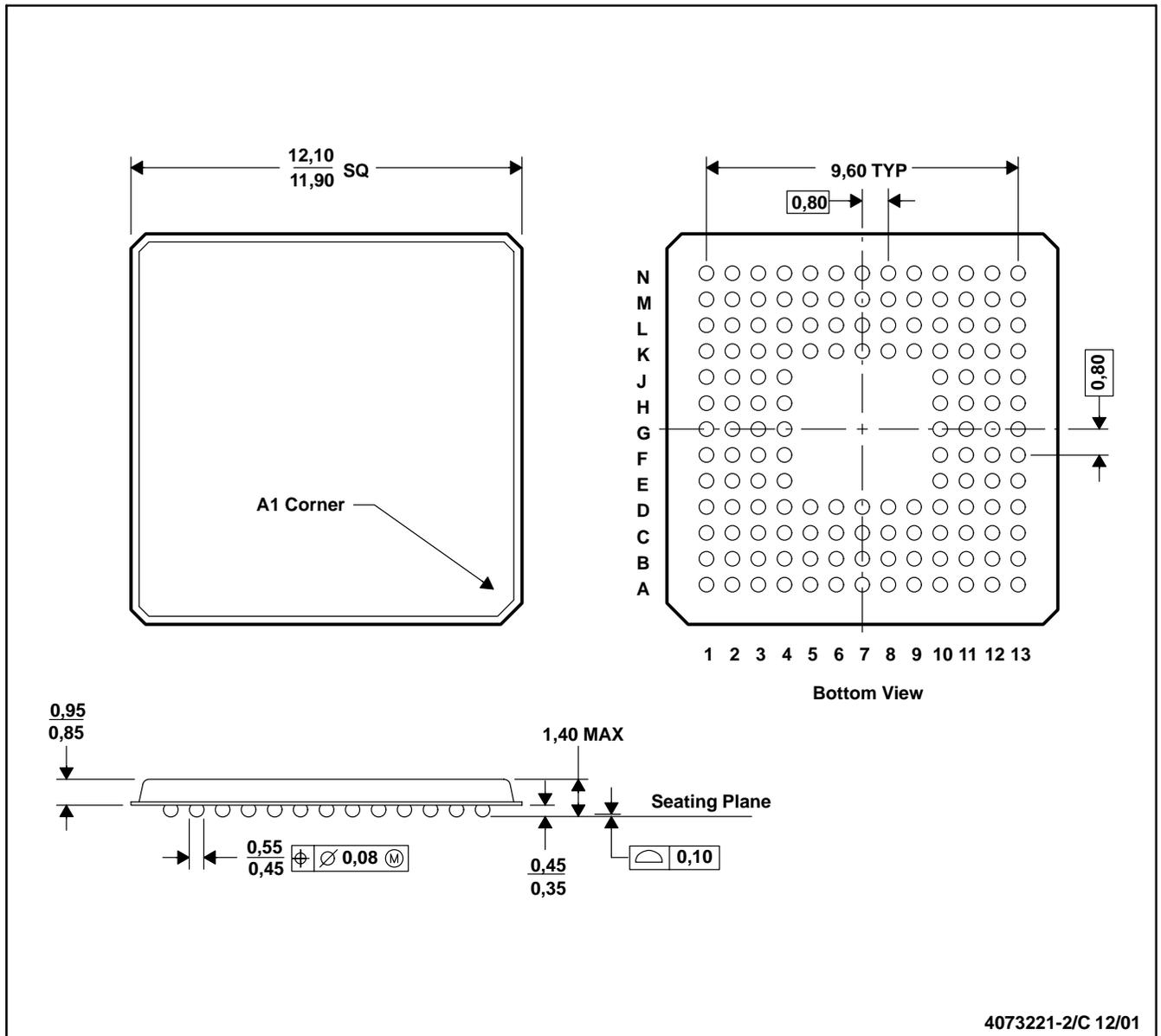
Chamfer on Tray corner indicates Pin 1 orientation of packed units.

\*All dimensions are nominal

| Device            | Package Name | Package Type | Pins | SPQ | Unit array matrix | Max temperature (°C) | L (mm) | W (mm) | K0 (µm) | P1 (mm) | CL (mm) | CW (mm) |
|-------------------|--------------|--------------|------|-----|-------------------|----------------------|--------|--------|---------|---------|---------|---------|
| TMS320LC548PGE-66 | PGE          | LQFP         | 144  | 60  | 5X12              | 150                  | 315    | 135.9  | 7620    | 25.4    | 17.8    | 17.55   |
| TMS320LC548PGE-80 | PGE          | LQFP         | 144  | 60  | 5X12              | 150                  | 315    | 135.9  | 7620    | 25.4    | 17.8    | 17.55   |

GGU (S-PBGA-N144)

PLASTIC BALL GRID ARRAY



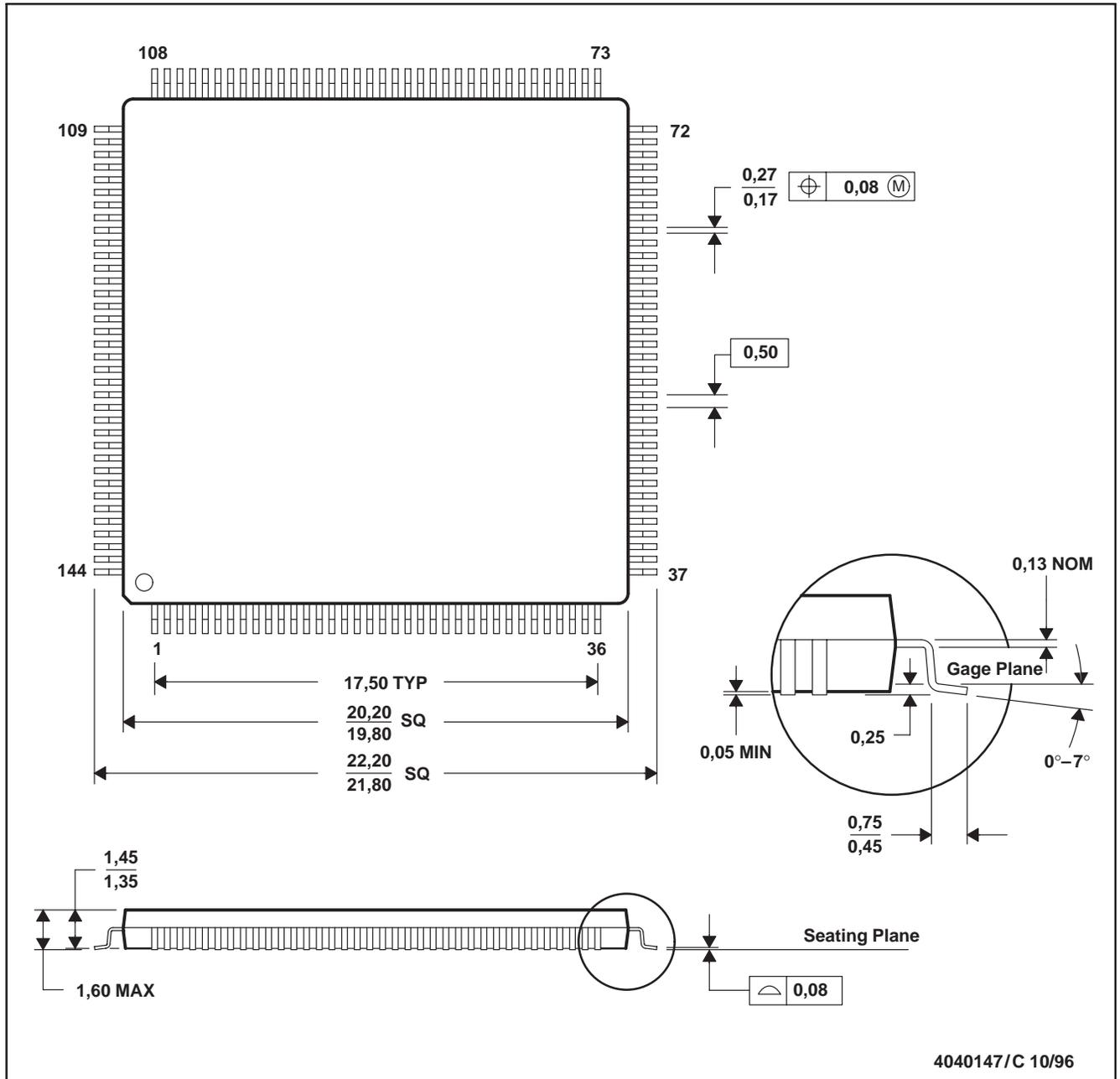
- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice  
 C. MicroStar BGA™ configuration

MicroStar BGA is a trademark of Texas Instruments Incorporated.



PGE (S-PQFP-G144)

PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-026

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